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GENERAL

INTRODUCTION

SCOPE OF THIS MANUAL

This manual is intended for use by experienced technicians familiar with similar types of commercial grade communications equipment. It contains all required service information for the equipment and is current as of the publication date. Changes which may occur after publication are covered by either Service Bulletins or Manual Revisions. These are issued as required.

ORDERING REPLACEMENT PARTS

When ordering replacement parts or equipment information, the full part identification number should be included. This applies to all parts, components, kits, or chassis. If the part number is not known, include the chassis or kit number of which it is a part, and a sufficient description of the required component for proper identification.

TK-3201

Destination	Number of CH	Frequency No. / Frequency / Signalling	RF power output
E, T	16 channel	CH1 446.00625MHz 94.8Hz CH2 446.09375MHz 88.5Hz CH3 446.03125MHz 103.5Hz CH4 446.06875MHz 79.7Hz CH5 446.04375MHz 118.8Hz CH6 446.01875MHz 123.0Hz CH7 446.08125MHz 127.3Hz CH8 446.05625MHz 85.4Hz CH9 446.00625MHz 107.2Hz CH10 446.09375MHz 110.9Hz CH11 446.03125MHz 114.8Hz CH12 446.06875MHz 82.5Hz CH13 446.04375MHz 132N CH14 446.01875MHz 155N CH15 446.05625MHz 134N CH16 446.08125MHz 243N	0.5W

PERSONAL SAFETY

The following precautions are recommended for personal safety:

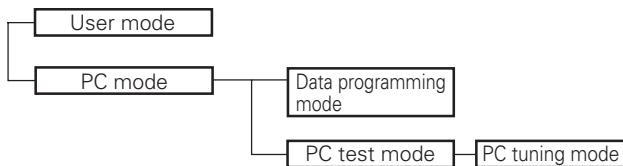
- DO NOT transmit until all RF connectors are verified secure and any open connectors are properly terminated.
- SHUT OFF and DO NOT operate this equipment near electrical blasting caps or in an explosive atmosphere.
- This equipment should be serviced by a qualified technician only.

SERVICE

This radio is designed for easy servicing. Refer to the schematic diagrams, printed circuit board views, and alignment procedures contained within.

REALIGNMENT

1. Modes

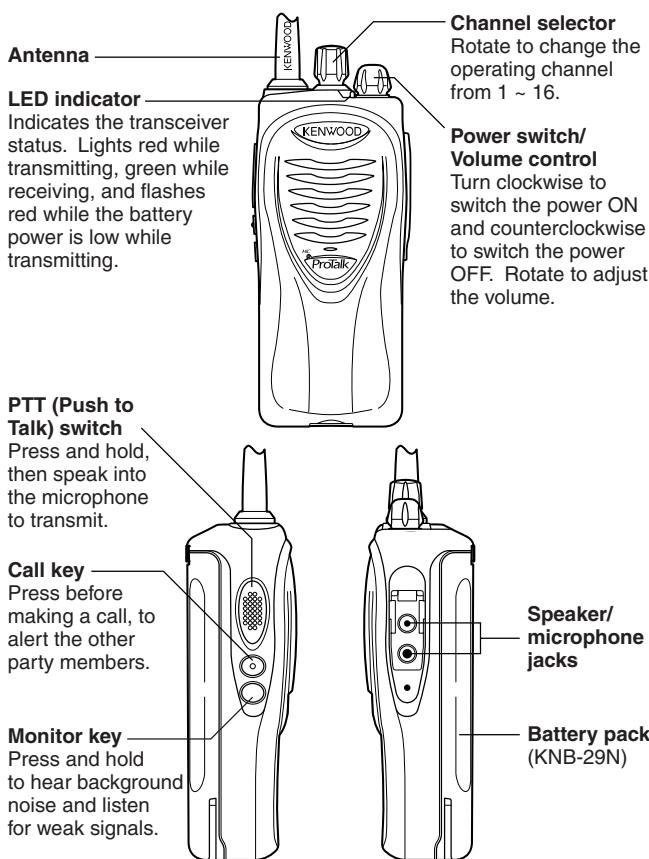


Mode	Function
User mode	For normal use.
PC mode	Used for communication between the radio and PC (IBM compatible).
Data programming mode	Used to read and write frequency data and other features to and from the radio.
PC test mode	Used to check the radio using the PC. This feature is included in the KPG-90D.

2. How to Enter Each Mode

Mode	Operation
User mode	Power ON
PC mode	Received commands from PC

3. Getting Acquainted



4. PC Mode

4-1. Preface

The TK-3201 transceiver is programmed using a personal computer, a programming interface (KPG-22) and programming software (KPG-90D).

The programming software can be used with an IBM PC or compatible. Figure 1 shows the setup of an IBM PC for programming.

4-2. Connection procedure

1. Connect the TK-3201 to the personal computer with the interface cable.
2. When the POWER is switched on, user mode can be entered immediately. When the PC sends a command, the radio enters PC mode.
When data is transmitting from the transceiver, the red LED lights.
When data is received by the transceiver, the green LED lights.

When data is transmitted from the transceiver, the red LED lights.
When data is received by the transceiver, the green LED lights.

Notes:

- The data stored in the personal computer must match the model type when it is written into the EEPROM.
- Change the TK-3201 to PC mode, then attach the interface cable.

4-3. KPG-22 description

(PC programming interface cable: Option)

The KPG-22 is required to interface the TK-3201 with the computer. It has a circuit in its D-subconnector (25-pin) case that converts the RS-232C logic level to the TTL level.

The KPG-22 connects the SP/MIC connector of the TK-3201 to the computer's RS-232C serial port.

4-4. Programming software description

KPG-90D is the programming software for TK-3201 supplied on a CD-ROM. This software runs under Windows 98, ME, Windows 2000 or XP on an IBM-PC or compatible machine.

The data can be input to or read from TK-3201 and edited on the screen. The programmed or edited data can be printed out. It is also possible to tune the transceiver.

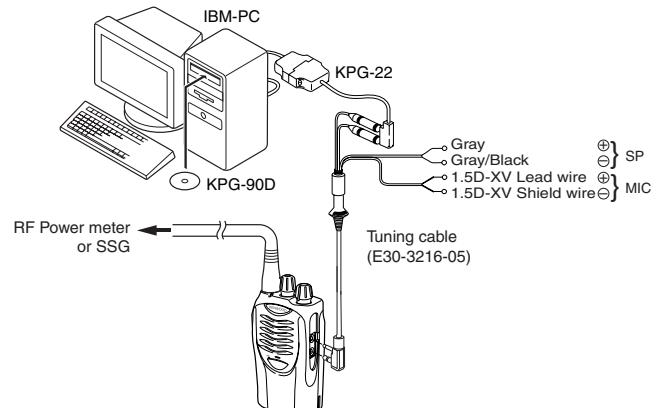
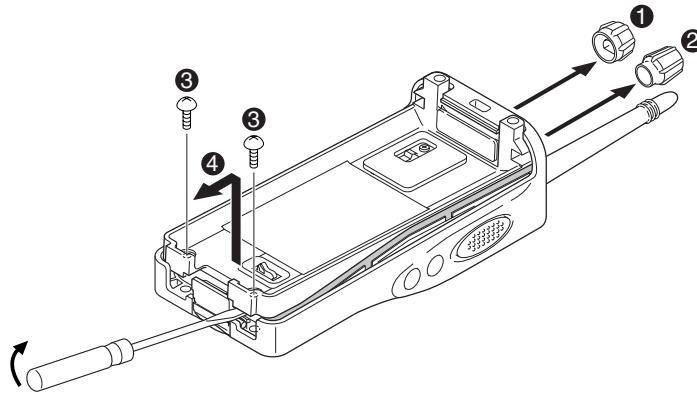


Fig. 1

DISASSEMBLY FOR REPAIR

■ Removing the case assembly from the chassis.

1. Remove the volume knob ① and channel knob ②.
2. Remove the two screws ③.
3. Lift and remove the chassis from the case assembly ④.
(Use a flat-blade screwdriver to easily lift the chassis.)

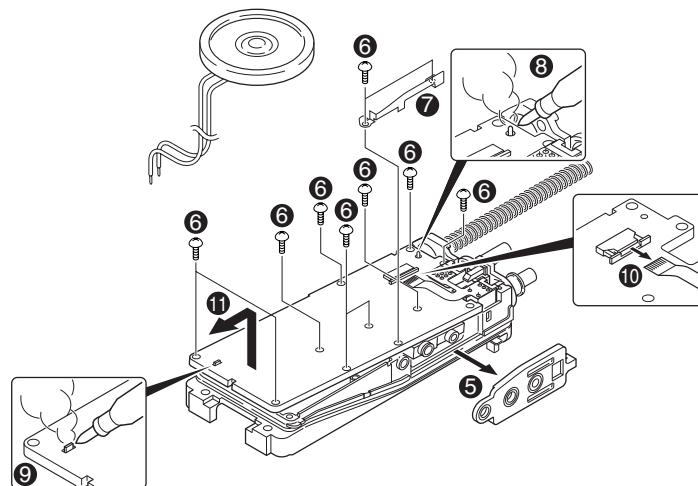


■ Removing the TX-RX unit from the chassis.

1. Remove the packing ⑤ from the SP / MIC jack of the TX-RX unit.
2. Remove the eleven screws ⑥ fixing the TX-RX unit.
3. Remove the fixing bracket ⑦ of the SP / MIC.
4. Remove the solder of the antenna terminal with a soldering iron ⑧.
5. Remove the solder of the positive terminal with a soldering iron ⑨.

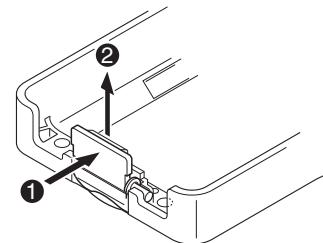
Note: You can remove the TX-RX unit from the chassis without removing the solder at the positive terminal. However, in this case, you can not attach the packing (G53-1605-03) that is on the positive terminal to the chassis in assembling. So, it is advisable to remove the solder on the positive terminal first.

6. Remove the FPC from the flat cable connector ⑩.
7. Lift and remove the TX-RX unit from the chassis ⑪.



■ Removing the battery release lever from the case assembly.

1. Press the upper part of the lever toward the inside of the case assembly. One side of the shaft will be removed ①.
2. Lift and remove the battery release lever from the case assembly ②.



■ Attaching the battery release lever to the case assembly.

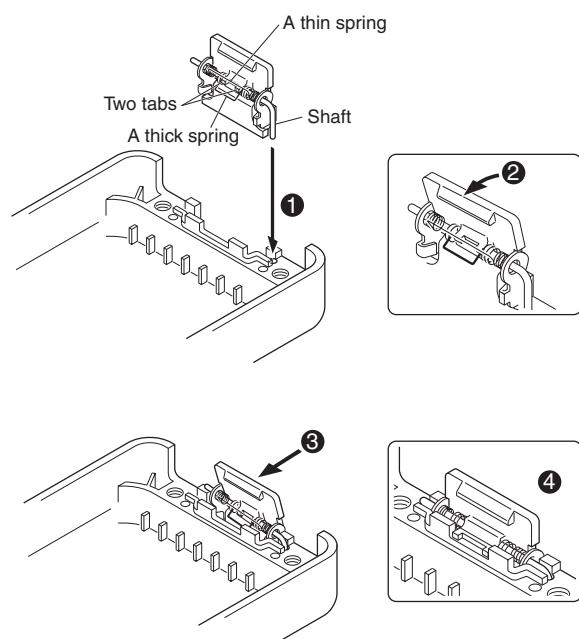
1. Insert one side of the shaft into the hole at the lever fitting section on the case assembly ①.

Caution : The thin spring (G01-4543-04) should be positioned above the two tabs of the lever.

2. Tilt the battery release lever slightly forward ②, so that the thick spring (G01-4542-04) is positioned below the case surface.
3. With the thick spring positioned below the case surface, attach the other side of the shaft to the case assembly by pressing the battery release lever ③ until it snaps into place ④.

Caution : Be careful not to tilt the battery release lever too forward.

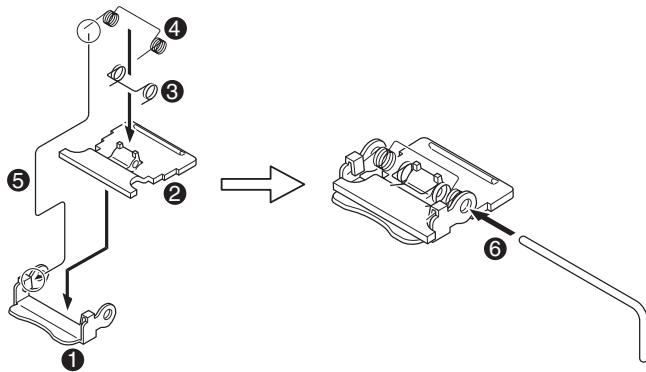
If the battery release lever is pushed in this state where the two tabs come below the case surface, there is a possibility of damaging the two tabs.



DISASSEMBLY FOR REPAIR

■ Assembling the battery release lever

1. Place the lever **②** onto the stopper **①**.
2. Place the thick spring **③** onto the lever.
3. Hook the right and left ends of the thin spring **④** onto the tabs of the stopper, then place the thin spring onto the lever **⑤**.
4. Slide the shaft through the hole of the stopper and lever **⑥**.

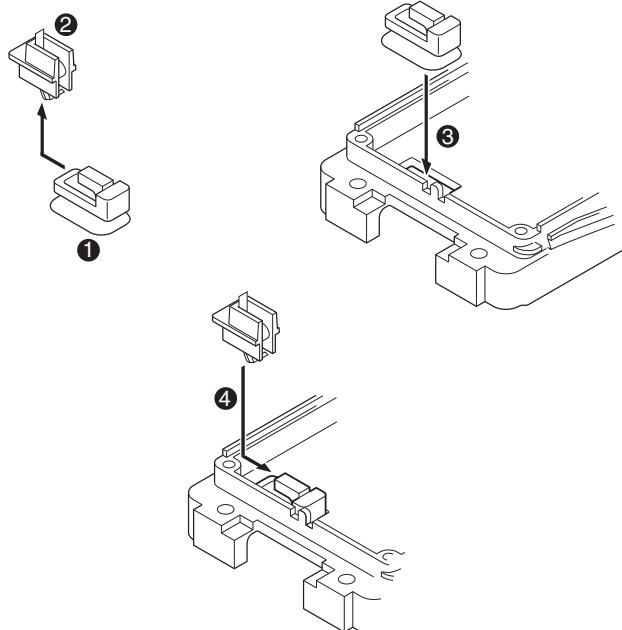


■ Cautions for assembly

1. Attaching the positive terminal to the chassis.

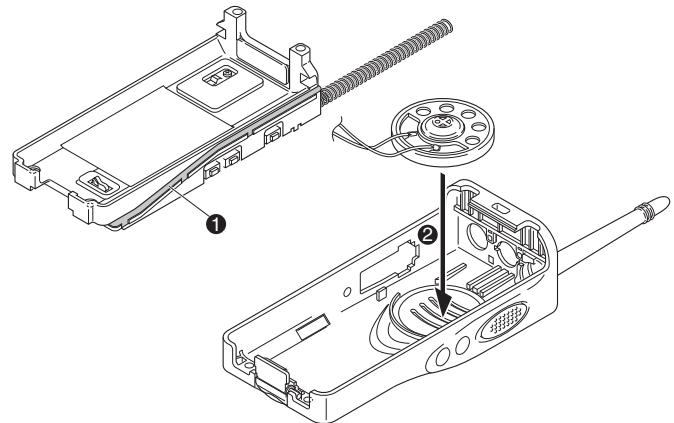
Always attach the positive terminal to the chassis, using the following procedures, before mounting the TX-RX unit onto the chassis.

1. Remove the holder assembly **②** from the packing **①** of the positive terminal.
2. Mount the packing of the positive terminal into the chassis hole **③**.
3. Mount the holder assembly into the packing of the positive terminal **④**.



2. Mounting the chassis to the case assembly.

1. Confirm that the waterproof packing attached to the circumference of the chassis is securely inserted in the groove of the chassis **①**.
2. Twist the speaker wires twice, then attach the speaker to the speaker recess of the case assembly **②**. Make sure the speaker is securely inserted.



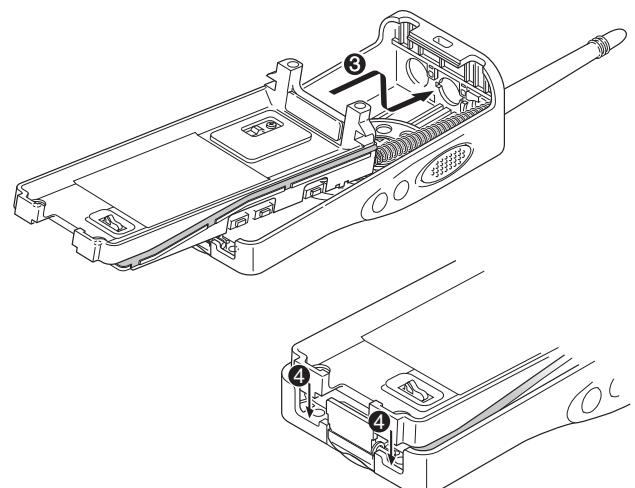
Confirm that the waterproof packing is securely inserted in the groove of the chassis.

3. Insert the antenna element into the cover **③**.

Caution: Take care that the speaker lead wire is not caught by the microphone element.

4. Press the chassis **④** and the case assembly together to attach them.

Caution: If the packing of the SP / MIC does not come to the correct position after attaching the chassis to the case assembly, reposition the packing with your fingers.



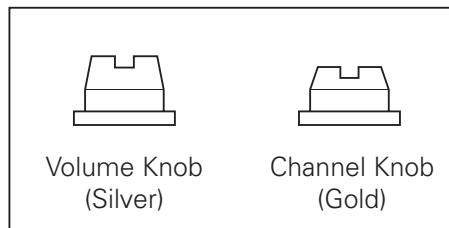
DISASSEMBLY FOR REPAIR

3. The nuts of the volume knob and channel knob

Note that the shapes, colors and heights of nuts of the volume knob and channel knob are different from one another. (The nut of volume knob is silver, and the nut of channel knob is gold)

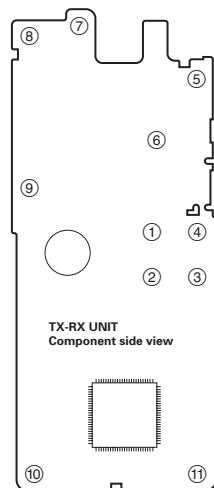
Use the following jig when removing the nuts of the volume knob and channel knob.

- Jig (Part No. : VW05-1012-00)



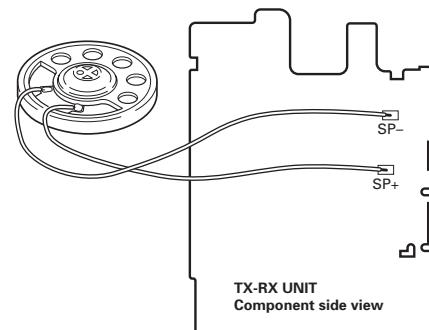
4. Screw sequence for mounting the TX-RX unit to the chassis.

Attach the TX-RX unit to the chassis using the screws in the order shown in the drawing below.



5. Connecting the speaker wires to the TX-RX unit

Note: To connect the speaker wires, you must solder it to the location of the TX-RX unit as illustrated below.



CIRCUIT DESCRIPTION

1. Frequency Configuration

The receiver utilizes double conversion. The first IF is 38.85 MHz and the second IF is 450 kHz. The first local oscillator signal is supplied from the PLL circuit.

The PLL circuit in the transmitter generates the necessary frequencies. Fig. 1 shows the frequencies.

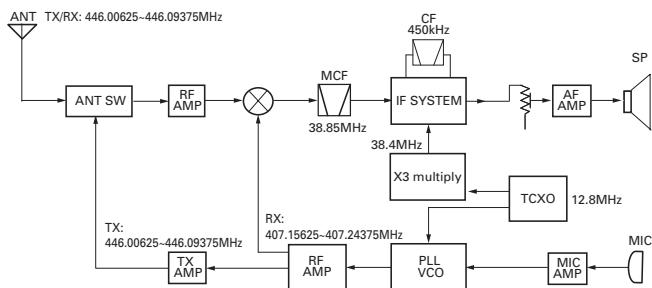


Fig. 1 Frequency configuration

2. Receiver

The frequency configuration of the receiver is shown in Fig. 2.

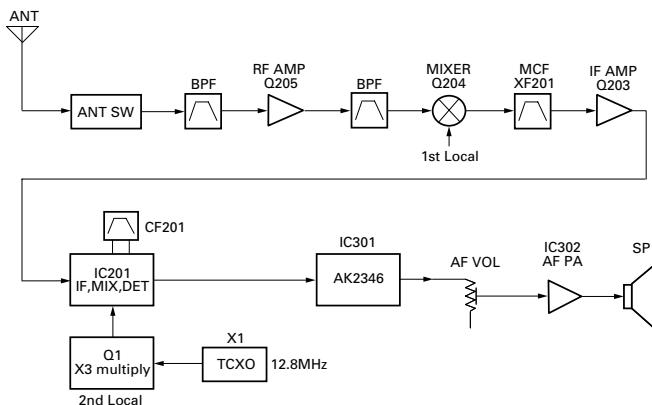


Fig. 2 Receiver section

1) Front End (RF AMP)

The signal coming from the antenna passes through the transmit/receive switching diode circuit, (D103,D104,D106 and D122) passes through a BPF (L229 and L228), and is amplified by the RF amplifier (Q205).

The resulting signal passes through a BPF (L214,L212) and goes to the mixer. These BPFs are fixed.

2) First Mixer

The signal from the front end is mixed with the first local oscillator signal generated in the PLL circuit by Q1 to produce a first IF frequency of 38.85 MHz.

The resulting signal passes through the XF201 MCF to cut the adjacent spurious and provide the optimum characteristics, such as adjacent frequency selectivity.

3) IF Amplifier Circuit

The first IF signal is passed through a four-pole monolithic crystal filter (XF201) to remove the adjacent channel signal. The filtered first IF signal is amplified by the first IF amplifier

(Q203) and then applied to the IF system IC (IC201). The IF system IC provides a second mixer, second local oscillator, limiting amplifier, quadrature detector and RSSI (Received Signal Strength Indicator). The second mixer mixes the first IF signal with the 38.4MHz of the second local oscillator output (TCXO X1) and produces the second IF signal of 450kHz.

The second IF signal is passed through the ceramic filter (CF201) to remove the adjacent channel signal. The filtered second IF signal is amplified by the limiting amplifier and demodulated by the quadrature detector with the ceramic discriminator (CD201). The demodulated signal is routed to the audio circuit.

4) Audio Amplifier Circuit

The demodulated signal from IC201 goes to AF amplifier through IC301.

The signal then goes through an AF volume control, and is routed to an audio power amplifier (IC302) where it is amplified and output to the speaker.

5) Squelch

Part of the AF signal from the IC enters the FM IC (IC201) again, and the noise component is amplified and rectified by a filter and an amplifier to produce a DC voltage corresponding to the noise level.

The DC signal from the FM IC goes to the analog port of the microprocessor (IC405). IC405 determines whether to output sounds from the speaker by checking whether the input voltage is higher or lower than the preset value.

To output sounds from the speaker, IC405 sends a high signal to the SP MUTE line and turns IC302 on through Q303,Q304,Q305,Q306 and Q316. (See Fig. 4)

6) Receive Signalling

(1) QT/DQT

The output signal from FM IC (IC201) enters the microprocessor (IC405) through IC301. IC405 determines whether the QT or DQT matches the preset value, and controls the SP MUTE and the speaker output sounds according to the squelch results.

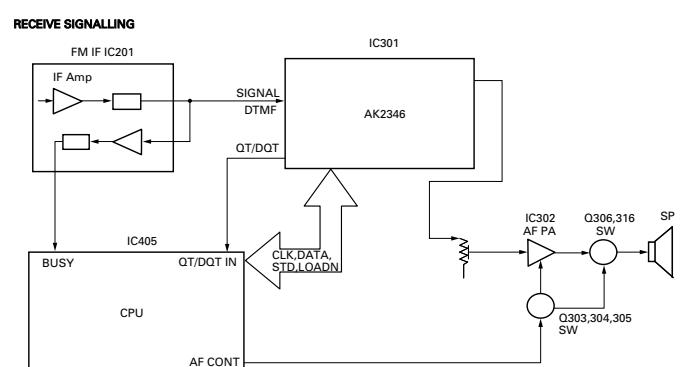


Fig. 3 AF amplifier and squelch

CIRCUIT DESCRIPTION

3. PLL Frequency Synthesizer

The PLL circuit generates the first local oscillator signal for reception and the RF signal for transmission.

1) PLL

The frequency step of the PLL circuit is 5 or 6.25kHz. A 12.8MHz reference oscillator signal is divided at IC1 by a fixed counter to produce oscillator (VCO) output signal which is buffered amplified by Q2 then divided in IC1 by a programmable counter. The divided signal is compared in phase with the 5 or 6.25kHz reference signal from the phase comparator in IC1. The output signal from the phase comparator is filtered through a low-pass filter and passed to the VCO to control the oscillator frequency.(See Fig. 4)

2) VCO

The operating frequency is generated by Q4. The oscillator frequency is controlled by applying the VCO control voltage, obtained from the phase comparator, to the varactor diodes (D4 and D7 in transmit mode). The RX pin is set high in receive mode causing Q5 turn on.

The TX pin is set high in transmit mode. The output from Q4 is amplified by Q6 and sent to the RF amplifiers.

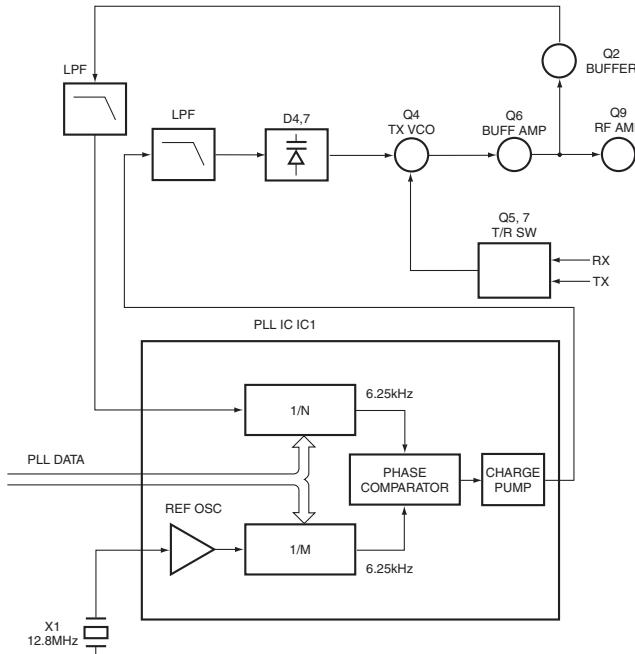


Fig. 4 PLL circuit

3) Unlock Detector

If a pulse signal appears at the LD pin of IC1, an unlock condition occurs, and the DC voltage obtained from C4, R5, and D1 causes the voltage applied to the microprocessor to go low. When the microprocessor detects this condition, the transmitter is disabled, ignoring the push-to-talk switch input signal.

4. Transmitter System

1) Microphone Amplifier

The signal from the microphone passes through IC301.

The signal passes through the Audio processor (IC301) for the maximum deviation adjustment and necessary process as pre-emphasized, and goes to the VCO modulation input.

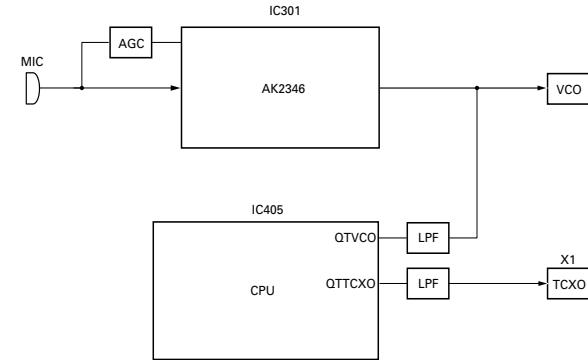


Fig. 5 Microphone amplifier

2) Drive and Final Amplifier

The signal from the T/R switch (D101 is on) is amplified by the pre-drive (Q101) and drive amplifier (Q102) to 50mW. The output of the drive amplifier is amplified by the RF power amplifier (Q103) to 0.5W. The RF power amplifier consists of two MOS FET stages. The output of the RF power amplifier is then passed through the harmonic filter (LPF) and antenna switch (D103 and D122) and applied to the antenna terminal.

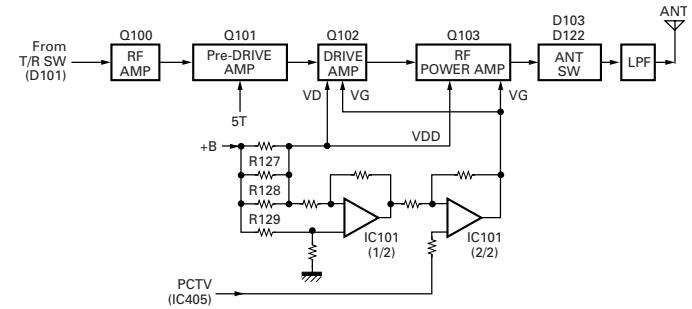


Fig. 6 Drive and final amplifier and APC circuit

3) APC Circuit

The APC circuit always monitors the current flowing through the RF power amplifier (Q103) and keeps a constant current. The voltage drop at R127, R128 and R129 is caused by the current flowing through the RF power amplifier and this voltage is applied to the differential amplifier IC101(1/2). IC101(2/2) compares the output voltage of IC101(1/2) with the reference voltage from IC405. The output of IC101(2/2) controls the VG of the RF power amplifier, Drive amplifier and Pre-Drive amplifier to make both voltages the same. The change of power high/low is carried out by the change of the reference voltage.

CIRCUIT DESCRIPTION

4) Encode Signalling

(1) QT/DQT

QT,DQT data of the QTTCXO Line is output from pin 28 of the CPU. The signal passes through a low-pass CR filter and goes to the TCXO(X1).

The QT,DQT data of the QTVCO Line is output from pin 24 of the CPU. The signal passes through a low pass CR filter, mixes with the audio signal, and goes to the VCO modulation input. TX deviation is adjusted by the CPU.

5. Power Supply

There are four 5V power supplies 5M,5C,5R, and 5T. 5M for microprocessor is always output while the power is on. 5M is always output, but turns off when the power is turned off to prevent malfunction of the microprocessor.

5C is a common 5V and is output when SAVE is not set to OFF.

5R is 5V for reception and output during reception.

5T is 5V for transmission and output during transmission.

6. Control Circuit

The control circuit consists of a microprocessor (IC405) and its peripheral circuits. It controls the TX-RX unit. IC405 mainly performs the following:

- (1) Switching between transmission and reception by the PTT signal input.
- (2) Reading system, group, frequency, and program data from the memory circuit.
- (3) Sending frequency program data to the PLL.
- (4) Controlling squelch on/off by the DC voltage from the squelch circuit.
- (5) Controlling the audio mute circuit by the decode data input.
- (6) Transmitting tone and encode data.

1) Memory Circuit

Memory circuit consists of the CPU (IC405) and an EEPROM (IC406). An EEPROM has a capacity of 64k bits that contains the transceiver control program for the CPU and data such as transceiver channels and operating features.



Fig. 7 Memory circuit

2) Low Battery Warning

The battery voltage is checked using by the microprocessor. The transceiver generates a warning tone when it falls below the warning voltage shown in the table.

- (1) The red LED blinks when the battery voltage falls below the voltage (1) shown in the table during transmission.

Note:

The transceiver checks the battery voltage during reception even when, in the FPU, the Battery Warning status function is set to "On TX" (default setting).

However, the LED does not blink during reception. During transmission, the LED blinks to generate the warning tone of a low battery voltage.

- (2) The transceiver immediately stops transmission when the battery voltage falls below the voltage (2) shown in the table. A message tone beeps while the PTT switch is released.

	Ni-Cd Battery	Ni-MH Battery
(1)	6.2[V]	6.2[V]
(2)	5.9[V]	5.9[V]

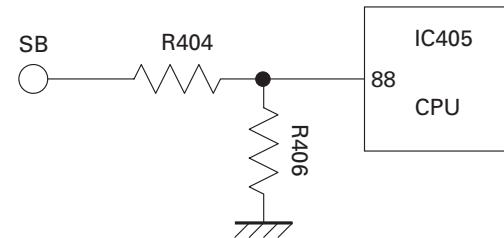


Fig. 8 Low battery warning

7. Control System

Keys and channel selector circuit.

The signal from keys and channel selector input to microprocessor directly as shown in fig. 9.

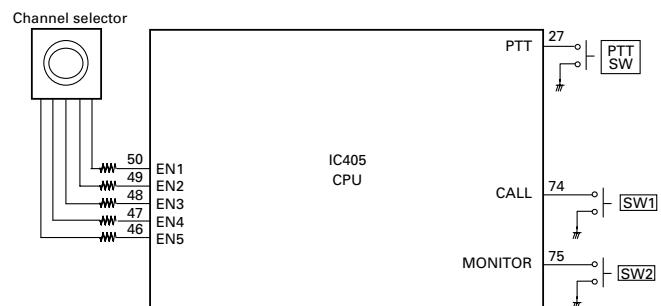


Fig. 9 Control system

TK-3201

TERMINAL FUNCTION / SEMICONDUCTOR DATA

TERMINAL FUNCTION

■ CN401

Pin No.	Name	I/O	Function
1	B	I	B (Battery Voltage)
2	SB	O	Switched B
3	SP1	I	Audio input
4	SP2	O	Audio output
5	GND	-	GND
6	EN1	I	Encoder pulse input

Pin No.	Name	I/O	Function
7	EN2	I	Encoder pulse input
8	GND	-	GND
9	EN3	I	Encoder pulse input
10	EN4	I	Encoder pulse input
11	EN5	I	Encoder pulse input

SEMICONDUCTOR DATA

Microprocessor : 30622MAA-B91GP (TX-RX UNIT : IC405)

■ Pin function

Pin No.	Port Name	I/O	Function
1	PCTV	O	APC/BPF control data output
2	DTMF	O	DTMF/BEEP Output
3	NC	-	NC
4	EEPDAT	I/O	EEPROM data input/output
5	EEPCLK	O	EEPROM clock output
6	BYTE	-	GND
7	GND	-	GND
8	BSHIFT	O	Beat shift switch
9	NC	-	NC
10	RESET	I	CPU reset
11	XOUT	O	CPU clock (7.3728MHz)
12	VSS	-	GND
13	XIN	I	CPU clock (7.3728MHz)
14-15	VCC	-	+5V
16	INT	I	Battery voltage monitor input
17	TCLK/DTRDO	I	Base band IC data input
18	RDF/FD	I	Base band IC data input
19	SCLK	O	Base band IC clock output
20	D I/O	I/O	Base band IC data input/output
21	TDATA/DTRCLK	O	Base band IC data output
22	DIR	O	Base band IC data output
23	NC	-	NC
24	QT VCO	O	QT/DQT output
25	NC	-	NC
26	1/2 OSC	O	3.6864 MHz (7.3728 MHz/2)
27	PTT	I	PTT switch input
28	QT TCXO	O	QT/DQT output
29	TXD	O	Serial data (FPU/FLASH)
30	RXD	I	Serial data (FPU/FLASH)
31	GND	-	GND
32	APCSW	O	APC switch
33-34	NC	-	NC
35	DCSW	O	APC voltage discharge switch
36	TX_W/N	O	TX Wide/Narrow switch
37	RX_SW	O	RX VCO switch
38	TX_SW	O	TX VCO switch
39	GND	-	GND
40	PLL_UL	I	PLL unlock detect input
41	PLL_STB	O	PLL strobe output
42	PLL_DAT	O	PLL data output
43	PLL_CLK	O	PLL clock output

Pin No.	Port Name	I/O	Function
44	VCC	-	+5V
45	RX_W/N	O	RX Wide/Narrow switch
46	EN5	I	Channel selectable input
47	EN4	I	Channel selectable input
48	EN3	I	Channel selectable input
49	EN2	I	Channel selectable input
50	EN1	I	Channel selectable input
51	OPTDET	I	Headset input detect
52	AF_CONT	O	Speaker mute
53	Calling Alert SW	O	Calling alert switch
54-59	NC	-	NC
60	VCC	-	+5V
61	NC	-	NC
62	VSS	-	GND
63-64	GND	-	GND
65-71	NC	-	NC
72	LEDTX	O	Red LED lights control output
73	LEDRX	O	Green LED lights control output
74	PF1	I	Call key input
75	PF2	I	Monitor key input
76	SIM1	-	GND
77	SIM2	-	GND
78-79	NC	-	NC
80	5T_C	O	5T control output
81	5R_C	O	5R control output
82	5C_C	O	5C control output
83-87	NC	-	NC
88	BATT	I	Battery voltage input
89	RSSI	I	Received Signal Strength Indicator input
90	BUSY	I	Busy level input
91	VOX	I	VOX level input
92	QT/DQT_IN	I	QT/DQT input
93	TH_DET	I	Thermistor input
94	AVSS	-	GND
95	NC	-	NC
96	VREF	-	+5V
97	AVCC	-	+5V
98	NC	-	NC
99	MIC_Mute	O	MIC mute
100	NC	-	NC

COMPONENTS DESCRIPTION

TX-RX UNIT (X57-6972-70)

Ref. No.	Use/Function	Operation/Condition
IC1	IC	PLL system
IC101	IC	Comparator (APC)
IC201	IC	FM IF system
IC301	IC	Audio processor
IC302	IC	AF AMP
IC401	IC	Voltage Regulator/ 5V
IC402	IC	Voltage Regulator/ 5V
IC403	IC	Voltage detector / Reset
IC404	IC	Voltage detector / Int
IC405	IC	Microprocessor
IC406	IC	EEPROM
IC408	IC	MIC AMP
Q1	Transistor	Tripler
Q2	Transistor	PLL IC f_in AMP
Q4	FET	VCO
Q6	Transistor	RF Buffer AMP
Q8	Transistor	Ripple filter
Q9	Transistor	RF AMP
Q100	Transistor	RF AMP
Q101	FET	RF AMP
Q102	FET	TX Drive AMP
Q103	FET	TX Final AMP
Q104	Transistor	APC switch
Q105	FET	APC switch
Q107	Transistor	APC switch
Q108	FET	APC switch
Q109	Transistor	APC switch
Q203	Transistor	IF AMP
Q204	FET	Mixer
Q205	FET	RF AMP
Q301	Transistor	W/N switch / TX
Q302	Transistor	MIC AGC
Q303	Transistor	DC switch / SP Mute
Q304	Transistor	DC switch
Q305	Transistor	DC switch / SP Mute
Q306	FET	SP Mute switch
Q316	FET	SP Mute switch
Q317	Transistor	Caller Alert
Q401	Transistor	LED switch / Red
Q402	Transistor	LED switch / Green
Q403	FET	5T switch
Q404	FET	5R switch
Q405	Transistor	5C switch
Q407	FET	Beat Shift switch
Q408	FET	Beat Shift switch

Ref. No.	Use/Function	Operation/Condition
D1	Diode	Ripple Filter
D2	Variable Capacitance Diode	Frequency control
D4	Variable Capacitance Diode	Frequency control
D6	Variable Capacitance Diode	Frequency control
D7	Variable Capacitance Diode	Frequency control
D10	Variable Capacitance Diode	Modulator
D11	Diode	Current steering
D101	Diode	TX/RX RF switch
D102	Zener Diode	APC protect
D103	Diode	ANT switch
D104	Diode	ANT switch
D106	Diode	ANT switch
D122	Diode	ANT switch
D202	Diode	TX/RX RF switch
D301	Diode	Detector
D302	Diode	Detector
D303	Diode	Isolation
D401	Diode	5V Protection
D402	Diode	Reverse Protection
D403	LED	LED/ Red
D404	LED	LED/ Green
D405	Zener Diode	Limiter

PARTS LIST

CAPACITORS

CC	45	TH	1H	220	J
1	2	3	4	5	6

1 = Type ... ceramic, electrolytic, etc.

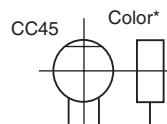
4 = Voltage rating

2 = Shape ... round, square, ect.

5 = Value

3 = Temp. coefficient

6 = Tolerance



Capacitor value

010 = 1pF

100 = 10pF

101 = 100pF

102 = 1000pF = 0.001μF

103 = 0.01μF

2 2 0 = 22pF

Multiplier

2nd number

1st number

Temperature coefficient

1st Word	C	L	P	R	S	T	U
Color*	Black	Red	Orange	Yellow	Green	Blue	Violet
ppm/°C	0	-80	-150	-220	-330	-470	-750

2nd Word	G	H	J	K	L
ppm/°C	±30	±60	±120	±250	±500

Example : CC45TH = -470 ± 60ppm/°C

Tolerance (More than 10pF)

Code	C	D	G	J	K	M	X	Z	P	No code	
(%)	±0.25	±0.5	±2	±5	±10	±20	+ 40	+ 80	+ 100	More than 10μF	-10 ~ +50
							- 40	- 20	- 0	Less than 4.7μF	-10 ~ +75

(Less than 10pF)

Code	B	C	D	F	G
(pF)	±0.1	±0.25	±0.5	±1	±2

Voltage rating

2nd word	A	B	C	D	E	F	G	H	J	K	V
1st word											
0	1.0	1.25	1.6	2.0	2.5	3.15	4.0	5.0	6.3	8.0	-
1	10	12.5	16	20	25	31.5	40	50	63	80	35
2	100	125	160	200	250	315	400	500	630	800	-
3	1000	1250	1600	2000	2500	3150	4000	5000	6300	8000	-

Chip capacitors

(EX) C C 7 3 F S L 1 H 0 0 0 J
 1 2 3 4 5 6 7 Refer to the table above.
 (Chip)(CH,RH<UJ,SL)

(EX) C K 7 3 F F 1 H 0 0 0 Z
 1 2 3 4 5 6 7
 (Chip)(B,F)

RESISTORS

Chip resistor (Carbon)

(EX) R K 7 3 E B 2 B 0 0 0 J
 1 2 3 4 5 6 7
 (Chip)(B,F)

Carbon resistor (Nomal type)

(EX) R D 1 4 B B 2 C 0 0 0 J
 1 2 3 4 5 6 7

1 = Type

2 = Shape

3 = Dimension

4 = Temp. coefficient

5 = Rating wattage

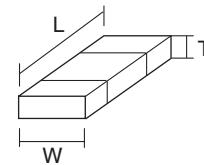
6 = Value

7 = Tolerance

Dimension (Chip capacitors)

Dimension code	L	W	T
Empty	5.6 ± 0.5	5.0 ± 0.5	Less than 2.0
A	4.5 ± 0.5	3.2 ± 0.4	Less than 2.0
B	4.5 ± 0.5	2.0 ± 0.3	Less than 2.0
C	4.5 ± 0.5	1.25 ± 0.2	Less than 1.25
D	3.2 ± 0.4	2.5 ± 0.3	Less than 1.5
E	3.0 ± 0.2	1.6 ± 0.2	Less than 1.25
F	2.0 ± 0.3	1.25 ± 0.2	Less than 1.25
G	1.6 ± 0.2	0.8 ± 0.2	Less than 1.0
H	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05

Dimension



Dimension (Chip resistor)

Dimension code	L	W	T
E	3.2 ± 0.2	1.6 ± 0.2	1.0
F	2.0 ± 0.3	1.25 ± 0.2	1.0
G	1.6 ± 0.2	0.8 ± 0.2	0.5 ± 0.1
H	1.0 ± 0.05	0.5 ± 0.05	0.35 ± 0.05

Rating wattage

Code	Wattage	Code	Wattage	Code	Wattage
1J	1/16W	2C	1/6W	3A	1W
2A	1/10W	2E	1/4W	3D	2W
2B	1/8W	2H	1/2W		

PARTS LIST

* New Parts. Δ indicates safety critical components.
 Parts without **Parts No.** are not supplied.
 Les articles non mentionnés dans le **Parts No.** ne sont pas fournis.
 Teile ohne **Parts No.** werden nicht geliefert.

L: Scandinavia
 Y: PX (Far East, Hawaii)
 Y: AAFES (Europe)

K: USA
 T: England
 X: Australia

P: Canada
 E: Europe
 M: Other Areas

TK-3201 (Y50-593X-XX)
TX-RX UNIT (X57-6972-70)

Ref. No.	Address	New parts	Parts No.	Description	Destination	Ref. No.	Address	New parts	Parts No.	Description	Destination
TK-3201											
1	1A	*	A02-3888-03	CABINET ASSY(16CH)		A	2B	*	N14-0818-04	CIRCULAR NUT(CH KNOB)	
2	3A		A10-4078-31	CHASSIS		B	2B		N14-0819-04	CIRCULAR NUT(VOL KNOB)	
3	1B		A21-1644-13	DRESSING PANEL		D	3A		N30-2606-46	PAN HEAD MACHINE SCREW(CHASSIS)	
4	2C		B09-0680-03	CAP(SP/MIC) ACCESSORY		E	2A,2B,3B		N83-2005-46	PAN HEAD TAPTITE SCREW(PCB)	
5	2B		B11-1817-04	ILLUMINATION GUIDE		54	1D		N99-2043-05	SCREW SET ACCESSORY	
6	1B		B43-1156-04	BADGE(KENWOOD)		55	3B		R31-0653-05	VARIABLE RESISTOR(POWER SW/VOL)	
7	1A		B43-1173-04	BADGE		56	2B		S60-0427-05	ROTARY SWITCH(16CH)	
8	1C		B62-1807-10	INSTRUCTION MANUAL		57	2B		T07-0369-05	SPEAKER	
9	1A		D10-0649-03	LEVER		58	2B	*	T90-1043-05	ANTENNA ELEMENT	
10	1A		D21-0863-04	SHAFT		59	2D		W08-0969-05	CHARGER ACCESSORY	
11	1A		D32-0441-03	STOPPER		60	3D		W08-0971-05	AC ADAPTER(2PIN) ACCESSORY	E
13	3A		E23-1253-04	TERMINAL(BATT-)		60	3D	*	W08-0972-05	AC ADAPTER(3PIN) ACCESSORY	T
15	2B	*	E37-1157-05	PROCESSED LEAD WIRE(SP+)							
16	2B	*	E37-1158-05	PROCESSED LEAD WIRE(SP-)							
17	1B	*	F07-1882-03	COVER(ANT)							
18	3A		F20-3353-14	INSULATING SHEET(CHASSIS BATT+)							
19	2A		G01-4542-04	COIL SPRING(LEVER)		C1			CK73HB1H332K	CHIP C 3300PF K	
20	1A		G01-4543-04	COIL SPRING(STOPPER)		C2			CK73HB1C682K	CHIP C 6800PF K	
21	2B		G10-1330-04	FIBROUS SHEET(C302:AUDIO IC)		C3			CK73GB1A105K	CHIP C 1.0UF K	
22	2A		G11-4283-04	RUBBER SHEET(Q103:FINAL FET)		C4			CK73HB1C103K	CHIP C 0.010UF K	
23	2A		G11-4313-04	SHEET(MIC ELEMENT)		C5			CK73HB1H102K	CHIP C 1000PF K	
24	1A		G11-4319-04	SHEET(PTT)		C6			CK73HB1A104K	CHIP C 0.10UF K	
25	3A		G13-2033-04	CUSHION(TERMINAL BATT-)		C7 ,8			CC73HCH1H101J	CHIP C 100PF J	
26	3B		G13-2034-14	CUSHION(TERMINAL BATT-)		C9			CC73HCH1H100C	CHIP C 10PF C	
27	2B		G13-2037-04	CUSHION(CHASSIS VOL/CH)		C10			C92-0713-05	CHIP-TAN 10UF 6.3WV	
28	3A		G13-2038-14	CUSHION(CHASSIS-CERAMIC FILTER)		C11			CC73HCH1H101J	CHIP C 100PF J	
29	2A		G13-2039-04	CUSHION(PCB-CERAMIC FILTER)		C12			CK73HB1H102K	CHIP C 1000PF K	
30	3B		G13-2045-04	CUSHION(CHASSIS)		C13			CK73HB1A104K	CHIP C 0.10UF K	
31	2B	*	G13-2076-04	CUSHION(SP)		C14			CK73HB1C103K	CHIP C 0.010UF K	
32	3A		G53-1604-03	PACKING(CHASSIS)		C15			CC73HCH1H100C	CHIP C 10PF C	
33	3A		G53-1605-03	PACKING(TERMINAL BATT+)		C16			CK73HB1H102K	CHIP C 1000PF K	
34	2B		G53-1606-03	PACKING(VOL/CH/LED)		C17			CC73HCH1H470J	CHIP C 47PF J	
35	1B		G53-1607-03	PACKING(SP/MIC)		C18			CC73HCH1H180J	CHIP C 18PF J	
36	2B		G53-1608-03	PACKING(SP)		C19			CK73HB1A104K	CHIP C 0.10UF K	
37	2A		G53-1609-14	PACKING(MIC ELEMENT)		C21			C92-0713-05	CHIP-TAN 10UF 6.3WV	
38	1B	*	G53-1611-04	PACKING(ANT)		C22			C92-0502-05	CHIP-TAN 0.33UF 35WV	
40	2C	*	H12-3172-05	PACKING FIXTURE		C24			CK73HB1H102K	CHIP C 1000PF K	
41	2C	*	H13-2112-03	CARTON BOARD		C25			CC73HCH1H020B	CHIP C 2.0PF B	
42	1C		H25-0085-04	PROTECTION BAG (100/200/0.07)		C26			CC73HCH1H300J	CHIP C 30PF J	
43	3C	*	H52-2065-02	ITEM CARTON CASE		C27			C92-0697-05	CHIP-TAN 3.3UF 16WV	
44	1D		J19-5472-03	HOLDER(SP/MIC) ACCESSORY		C29			CK73HB1H471K	CHIP C 470PF K	
45	2A		J19-5473-03	HOLDER ASSY(TERMINAL BATT+)		C32			C92-0001-05	CHIP C 0.11UF 35WV	
46	2B		J21-8477-04	HARDWARE FIXTURE(VOL/CH)		C33 ,34			CK73HB1H102K	CHIP C 1000PF K	
47	2B		J21-8478-04	HARDWARE FIXTURE(SP/MIC)		C35			CC73HCH1H270J	CHIP C 27PF J	
48	2D		J29-0713-05	BELT CLIP ACCESSORY		C38			CC73HCH1H050B	CHIP C 5.0PF B	
49	2B		J82-0092-05	FPC		C39			CK73GB1H332K	CHIP C 3300PF K	
50	1A		K29-9307-13	BUTTON KNOB(CALL/MONITOR)		C40			CC73HCH1H030B	CHIP C 3.0PF B	
51	1A		K29-9308-03	BUTTON KNOB(PTT)		C41			CK73GB1H682K	CHIP C 6800PF K	
52	1B		K29-9309-03	KNOB(VOL)		C42			CC73HCH1H050B	CHIP C 5.0PF B	
53	1B		K29-9318-03	KNOB(CH)		C43			CC73HCH1H100C	CHIP C 10PF C	
						C44			CK73HB1H471K	CHIP C 470PF K	
						C45			CK73GB1A105K	CHIP C 1.0UF K	

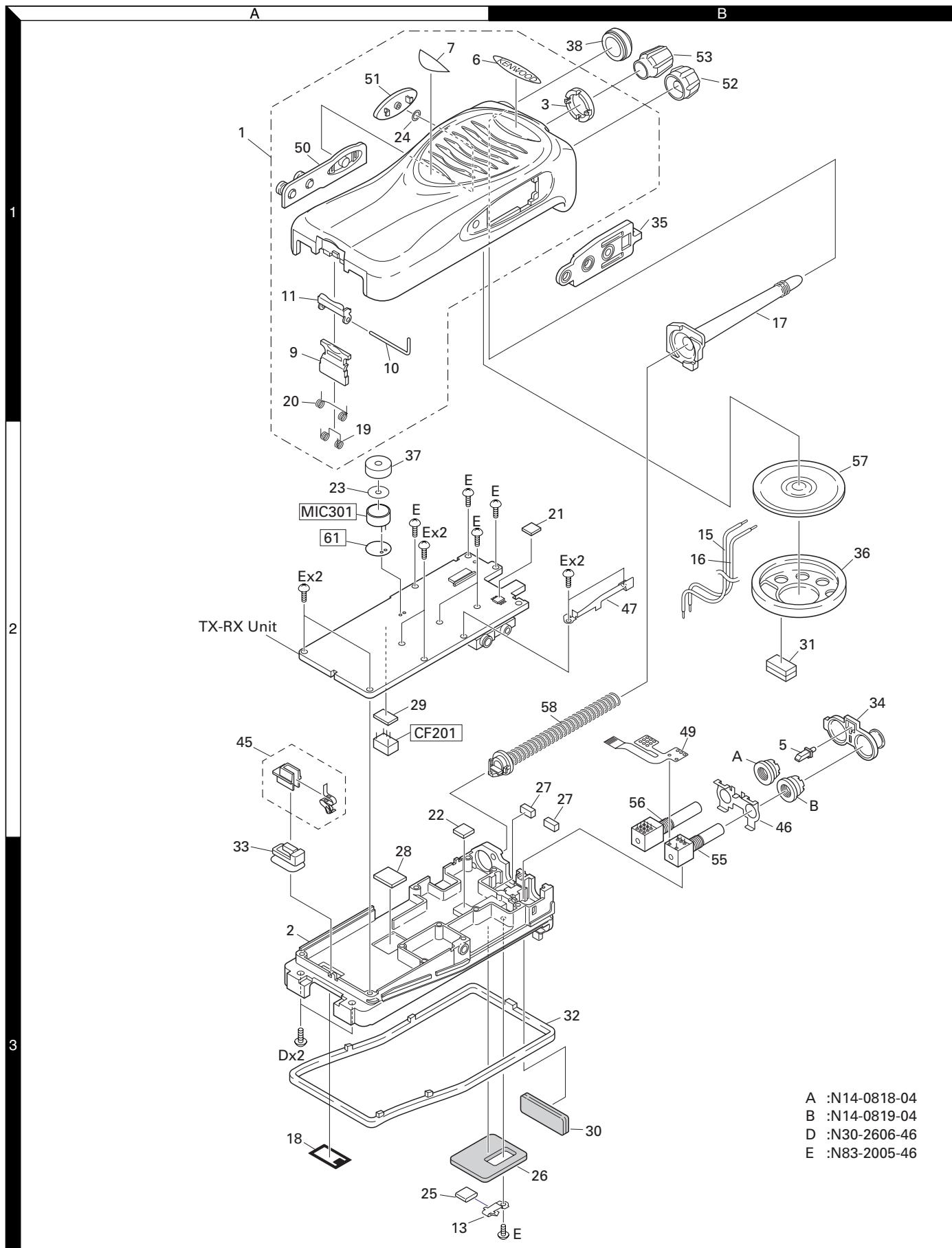
PARTS LIST

TX-RX UNIT (X57-6972-70)

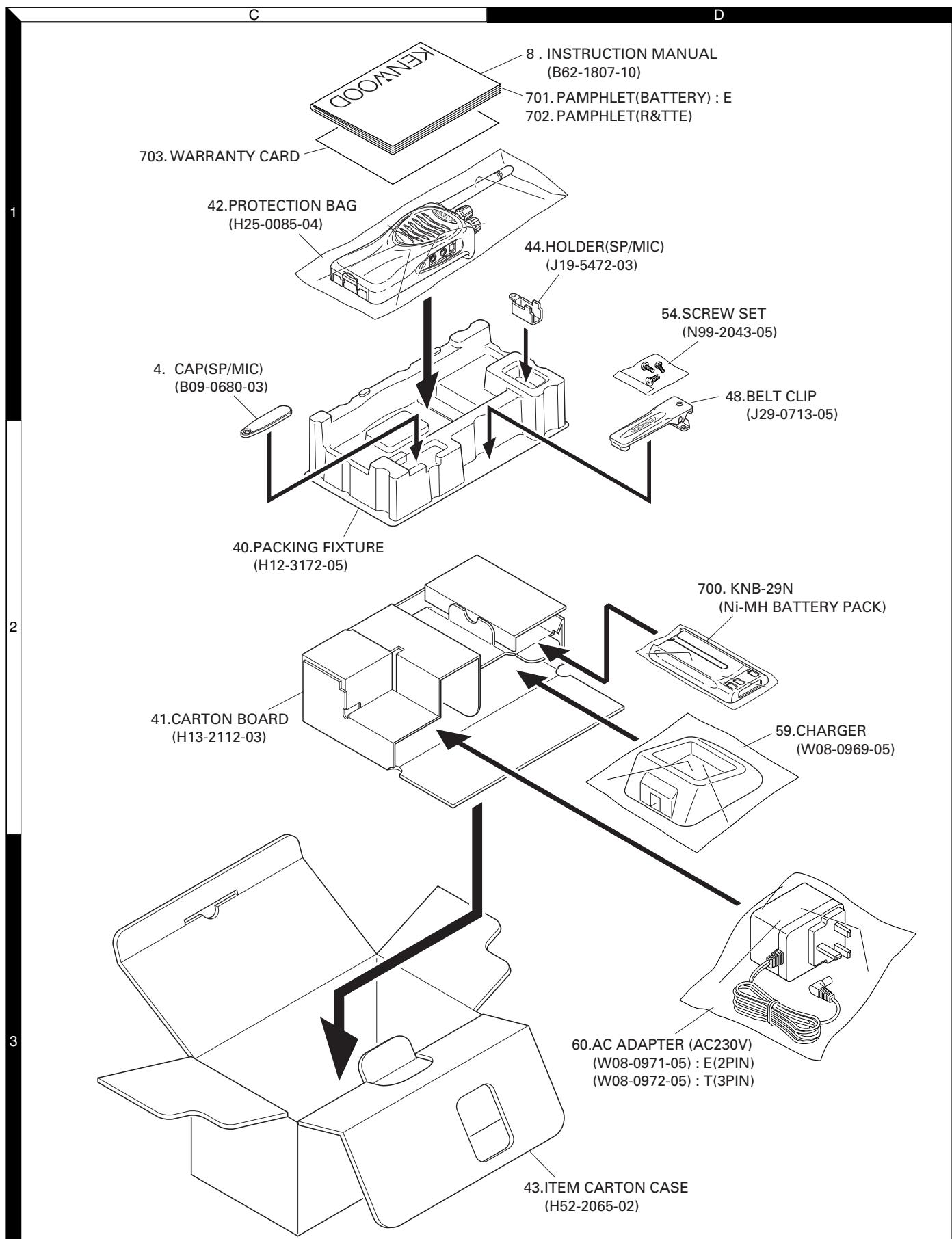
Ref. No.	Address	New parts	Parts No.	Description		Destination	Ref. No.	Address	New parts	Parts No.	Description	Destination
R324,325			RK73GB1J154J	CHIP R	150K	J 1/16W	D106			HVC131	DIODE	
R326			R92-1252-05	CHIP R	0 OHM	J 1/16W	D122			HVC131	DIODE	
R327			RK73GB1J184J	CHIP R	180K	J 1/16W	D202			HSC277	DIODE	
R328			RK73GB1J103J	CHIP R	10K	J 1/16W	D301,302		*	RB706F-40	DIODE	
R329			RK73GB1J154J	CHIP R	150K	J 1/16W	D303			MC2858	DIODE	
R330			RK73HB1J332J	CHIP R	3.3K	J 1/16W	D401			RB521S-30	DIODE	
R332			RK73GB1J153J	CHIP R	15K	J 1/16W	D402			1SR154-400	DIODE	
R334			RK73GB1J473J	CHIP R	47K	J 1/16W	D405			KDZ3.3V	ZENER DIODE	
R335			RK73GB1J222J	CHIP R	2.2K	J 1/16W	IC1			MB15A02	MOS IC	
R336			RK73GB1J102J	CHIP R	1.0K	J 1/16W	IC101			TA75W01FU	MOS IC	
R337			RK73GB1J151J	CHIP R	150	J 1/16W	IC201			TA31136FN	MOS IC	
R338			RK73HB1J222J	CHIP R	2.2K	J 1/16W	IC301			AK2346	MOS IC	
R339			RK73GB1J471J	CHIP R	470	J 1/16W	IC302			TA7368F	MOS IC	
R340			RK73GB1J182J	CHIP R	1.8K	J 1/16W	IC401,402			XC6204B502MR	MOS IC	
R341			RK73GB1J103J	CHIP R	10K	J 1/16W	IC403			BD4840FVE	MOS IC	
R342			RK73GB1J100J	CHIP R	10	J 1/16W	IC404			BD4845FVE	MOS IC	
R343			RK73GB1J474J	CHIP R	470K	J 1/16W	IC405			30622MAA-B91GP	MPU	
R344			RK73GB1J102J	CHIP R	1.0K	J 1/16W	IC406			BR24L08F-W	ROM IC	
R345,346			RK73GB1J101J	CHIP R	100	J 1/16W	IC408			NJM2100V	MOS IC	
R347			RK73GB1J104J	CHIP R	100K	J 1/16W	Q1			KTC4082	TRANSISTOR	
R348			RK73GB1J563J	CHIP R	56K	J 1/16W	Q2			2SC5108(Y)	TRANSISTOR	
R349			RK73GB1J333J	CHIP R	33K	J 1/16W	Q4			2SK508NV(K52)	FET	
R350			R92-1368-05	CHIP R	0 OHM		Q6			2SC5108(Y)	TRANSISTOR	
R354,355			RK73HB1J103J	CHIP R	10K	J 1/16W	Q8		*	2SC5383	TRANSISTOR	
R357			R92-1368-05	CHIP R	0 OHM		Q9			2SC4619(P,Q)	TRANSISTOR	
R360			R92-1368-05	CHIP R	0 OHM		Q100			2SC4619(P,Q)	TRANSISTOR	
R388			R92-1368-05	CHIP R	0 OHM		Q101			2SC5192	TRANSISTOR	
R403			RK73GB1J101J	CHIP R	100	J 1/16W	Q102		*	RD00HVS1	FET	
R404			RK73HH1J474D	CHIP R	470K	D 1/16W	Q103			RD02MUS1	FET	
R405			RK73GB1J334J	CHIP R	330K	J 1/16W	Q103		*	RD02MUS1-T22	FET	
R406			RK73HH1J474D	CHIP R	470K	D 1/16W	Q104		*	RT1N141U	TRANSISTOR	
R407			RK73HB1J334J	CHIP R	330K	J 1/16W	Q105		*	2SK879(Y)	FET	
R408-412			RK73HB1J473J	CHIP R	47K	J 1/16W	Q107		*	RT1N141U	TRANSISTOR	
R413,414			RK73GB1J331J	CHIP R	330	J 1/16W	Q108			2SK1824	FET	
R415-420			RK73HB1J473J	CHIP R	47K	J 1/16W	Q109			RT1P441U	TRANSISTOR	
R421,422			RK73HB1J102J	CHIP R	1.0K	J 1/16W	Q203			2SC4649(N,P)	TRANSISTOR	
R423			R92-1368-05	CHIP R	0 OHM		Q204,205			3SK318	FET	
R424,425			RK73HB1J473J	CHIP R	47K	J 1/16W	Q301		*	RT1P141U	TRANSISTOR	
R426			R92-1368-05	CHIP R	0 OHM		Q302			2SC4919	TRANSISTOR	
R435			RK73HB1J473J	CHIP R	47K	J 1/16W	Q303			RT1N441U	TRANSISTOR	
R436			R92-1252-05	CHIP R	0 OHM	J 1/16W	Q304			2SA1362(GR)	TRANSISTOR	
R437,438			RK73HB1J473J	CHIP R	47K	J 1/16W	Q305			RT1N441U	TRANSISTOR	
R447			RK73HB1J123J	CHIP R	12K	J 1/16W	Q306			CPH3413	FET	
R449,450			R92-1252-05	CHIP R	0 OHM	J 1/16W	Q316			CPH3413	FET	
R454,455			RK73GB1J271J	CHIP R	270	J 1/16W	Q317		*	2SK1824	FET	
R901			RK73GB1J472J	CHIP R	4.7K	J 1/16W	Q401,402		*	RT1N141U	TRANSISTOR	
VR1			R12-7491-05		TRIMMING POT.(68K)		Q403,404		*	CPH3317	FET	
S401-403			S70-0414-05		TACT SWITCH		Q405		*	RT1P237U	TRANSISTOR	
MIC301	2A	*	T91-0649-05		MIC ELEMENT		Q407,408			2SK1830	FET	
D1			MA2S111		DIODE		TH101			157-104-65001	THERMISTOR	
D2			HVC376B		VARIABLE CAPACITANCE DIODE		TH203			157-104-65001	THERMISTOR	
D4			HVC376B		VARIABLE CAPACITANCE DIODE							
D6 ,7			HVC376B		VARIABLE CAPACITANCE DIODE							
D10			1SV278		VARIABLE CAPACITANCE DIODE							
D11			MA2S111		DIODE							
D101			HSC277		DIODE							
D102			HZU5CLL		ZENER DIODE							
D103,104			HVC131		DIODE							

TK-3201

EXPLODED VIEW



PACKING



ADJUSTMENT

Test Equipment Required for Alignment

Test Equipment	Major Specifications	
1. Standard Signal Generator (SSG)	Frequency Range Modulation Output	446.0 to 446.1MHz Frequency modulation and external modulation. -127dBm/0.1µV to greater than -47dBm/1mV
2. Power Meter	Input Impedance Operation Frequency Measurement Range	50Ω. 446.0 to 446.1MHz Vicinity of 10W
3. Deviation Meter	Frequency Range	446.0 to 446.1MHz
4. Digital Volt Meter (DVM)	Measuring Range Input Impedance	10mV to 10V DC High input impedance for minimum circuit loading.
5. Oscilloscope		DC through 30MHz.
6. High Sensitivity Frequency Counter	Frequency Range Frequency Stability	10Hz to 1000MHz. 0.2ppm or less.
7. Ammeter		5A.
8. AF Volt Meter (AF VTVM)	Frequency Range Voltage Range	50Hz to 10kHz. 1mV to 10V.
9. Audio Generator (AG)	Frequency Range Output	50Hz to 5kHz or more. 0 to 1V.
10. Distortion Meter	Capability Input Level	3% or less at 1kHz. 50mV to 10Vrms.
11. Spectrum Analyzer	Measuring Range	DC to 1GHz or more
12. Tracking Generator	Center frequency Output Voltage	50kHz to 600MHz 100mV or more
13. 8Ω Dummy Load		Approx. 8Ω, 3W.
14. Regulated Power Supply		5V to 10V, approx. 3A Useful if ammeter equipped.

■ The following parts are required for adjustment

1. Antenna connector adapter

The antenna connector of this radio uses an SMA terminal.

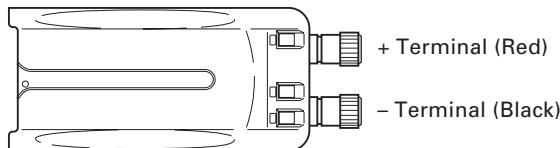
Use an antenna connector adapter [SMA(f) – BNC(f) or SMA(f) – N(f)] for adjustment. (The adapter is not provided as an option, so buy a commercially-available one.)

2. Repair Jig (Chassis)

Use jig (part No.: A10-4086-03) for repairing the TK-3201. Place the TX-RX unit on the jig and fit it with screws.

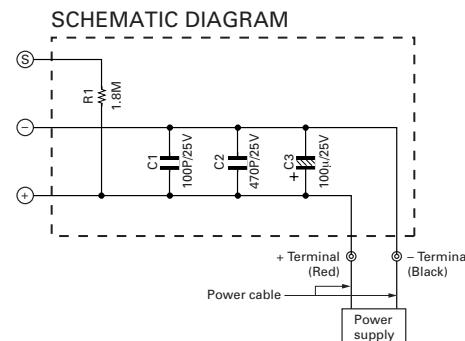
The jig facilitates the voltage check and protects the final amplifier FET when the voltage on the flow side of the TX-RX unit is checked during repairs.

3. Battery Jig (W05-1011-00)

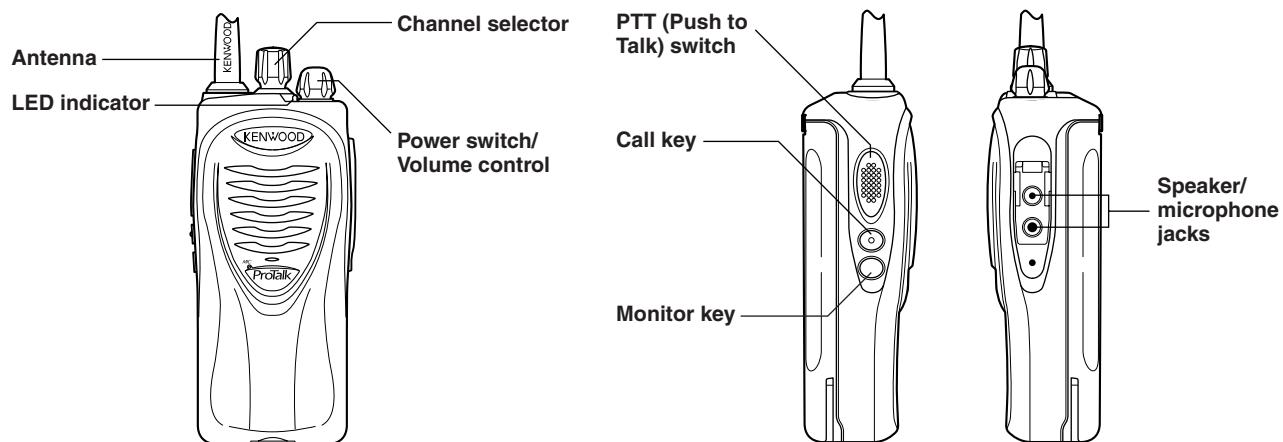
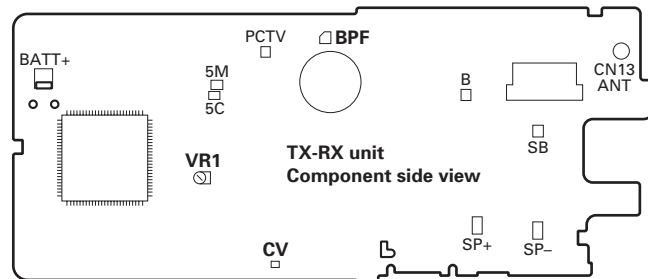


Connect the power cable properly between the battery jig installed in the transceiver and the power supply, and be sure output voltage and the power supply polarity prior to switching the power supply ON, otherwise over voltage and reverse connection may damage the transceiver, or the power supply or both.

Note: When using the battery jig, you must measure the voltage at the terminals of the battery jig. Otherwise, a slight voltage drop may occur within the power cable, between the power supply and the battery jig, especially while the transceiver transmits.



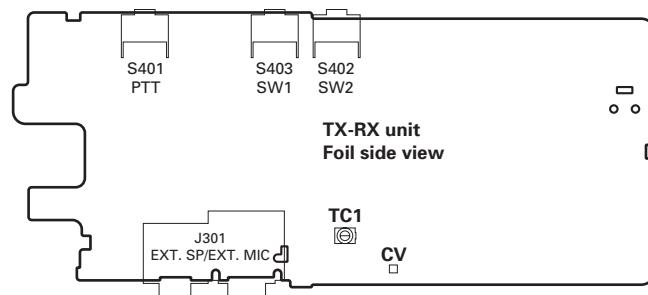
ADJUSTMENT

**Adjustment points****TX-RX unit (X57-697)****Component side view**

VR1 : Frequency adjustment

BPF : Band-pass wave form test point

CV : VCO lock voltage adjustment terminal

Foil Side View

TC1 : Transmit VCO lock voltage adjustment

CV : VCO lock voltage adjustment terminal

Fig. 1 Adjustment points**Frequency and signalling**

The set has been adjusted for the frequencies shown in the following table. When required, re-adjust them following the adjustment procedure to obtain the frequencies you want in actual operation.

Frequency (MHz)

Channel No.	RX Frequency	TX Frequency
1	446.00625	446.00625
2	446.01875	446.01875
3	446.03125	446.03125
4	446.04375	446.04375
5	446.05625	446.05625
6	446.06875	446.06875
7	446.08125	446.08125
8	446.09375	446.09375

Signalling

Signalling No.	RX	TX
1	None	None
2	None	100Hz Square Wave
3	QT 67.0Hz	QT 67.0Hz
4	QT 151.4Hz	QT 151.4Hz
5	QT 250.3Hz	QT 250.3Hz
6	DQT D023N	DQT D023N
7	DQT D754I	DQT D754I

Preparations for tuning the transceiver

Before attempting to tune the transceiver, connect the unit to a suitable power supply.

Whenever the transmitter is tuned, the unit must be connected to a suitable dummy load (i.e. power meter).

The speaker output connector must be terminated with a 8Ω dummy load and connected to an AC voltmeter and an audio distortion meter or a SINAD measurement meter at all times during tuning.

Adjustment Frequency

TEST CH	RX Frequency	TX Frequency
1	446.00625 MHz	446.00625 MHz
2	446.01875 MHz	446.01875 MHz
3	446.03125 MHz	446.03125 MHz
4	446.04375 MHz	446.04375 MHz
5	446.05625 MHz	446.05625 MHz
6	446.06875 MHz	446.06875 MHz
7	446.08125 MHz	446.08125 MHz
8	446.09375 MHz	446.09375 MHz

ADJUSTMENT

Common Section

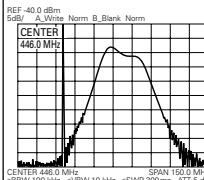
Item	Condition	Measurement		Adjustment		Specifications/ Remark
		Test equipment	Terminal	Parts	Method	
1.Setting	1) BATT terminal votage:7.5V 2) SSG standard modulation MOD:1kHz,DEV:1.5kHz					
2.VCO lock voltage TX	1) CH:5 PTT:ON	Power meter DVM	ANT CV	TC1	3.0 V	$\pm 0.1V$
3.VCO lock voltage RX	2) CH:1				Check	0.6V or more

Transmitter Section

Item	Condition	Measurement		Adjustment		Specifications/ Remark
		Test equipment	Terminal	Parts	Method	
1.Frequency Adjust	1) CH:5-1 PTT:ON	Frequency counter	ANT	VR1	446.05625MHz	$\pm 50Hz$
2.Power Adjust	TEST CH: 5-1 BATT terminal voltage:7.5V PTT:ON	Power meter Ammeter		Programming Software:KPG-90D		0.6W $\pm 0.05W$ 0.8A or less
3.VOX 1 Writing	TEST CH: 5-1 AG:1kHz/45mV	Power meter Deviation meter	ANT			
4.VOX 10 Writing	TEST CH:5-1 AG:1KHz/3.0mV	Oscilloscope AG	SP/MIC connector			
5.Max deviation Adjust	TEST CH: 6-1 AG:1kHz/150mV Deviation meter filter LPF:15kHz HPF:OFF PTT:ON	AF VTVM			2.2kHz (According to the lager +,-)	$\pm 50Hz$
6.DQT Balance Adjust	TEST CH: 6-1 LPF:3kHz HPF:OFF PTT:ON		ANT		Make the demodulation wave into square waves	
7.QT Deviation Adjust	TEST CH: 6-3 QT:67.0Hz LPF:3kHz HPF:OFF PTT:ON				0.40kHz	$\pm 40Hz$
8.DQT Deviation Adjust	TEST CH: 6-6 DQT:023 LPF:3kHz HPF:OFF PTT:ON				0.35kHz	$\pm 40Hz$

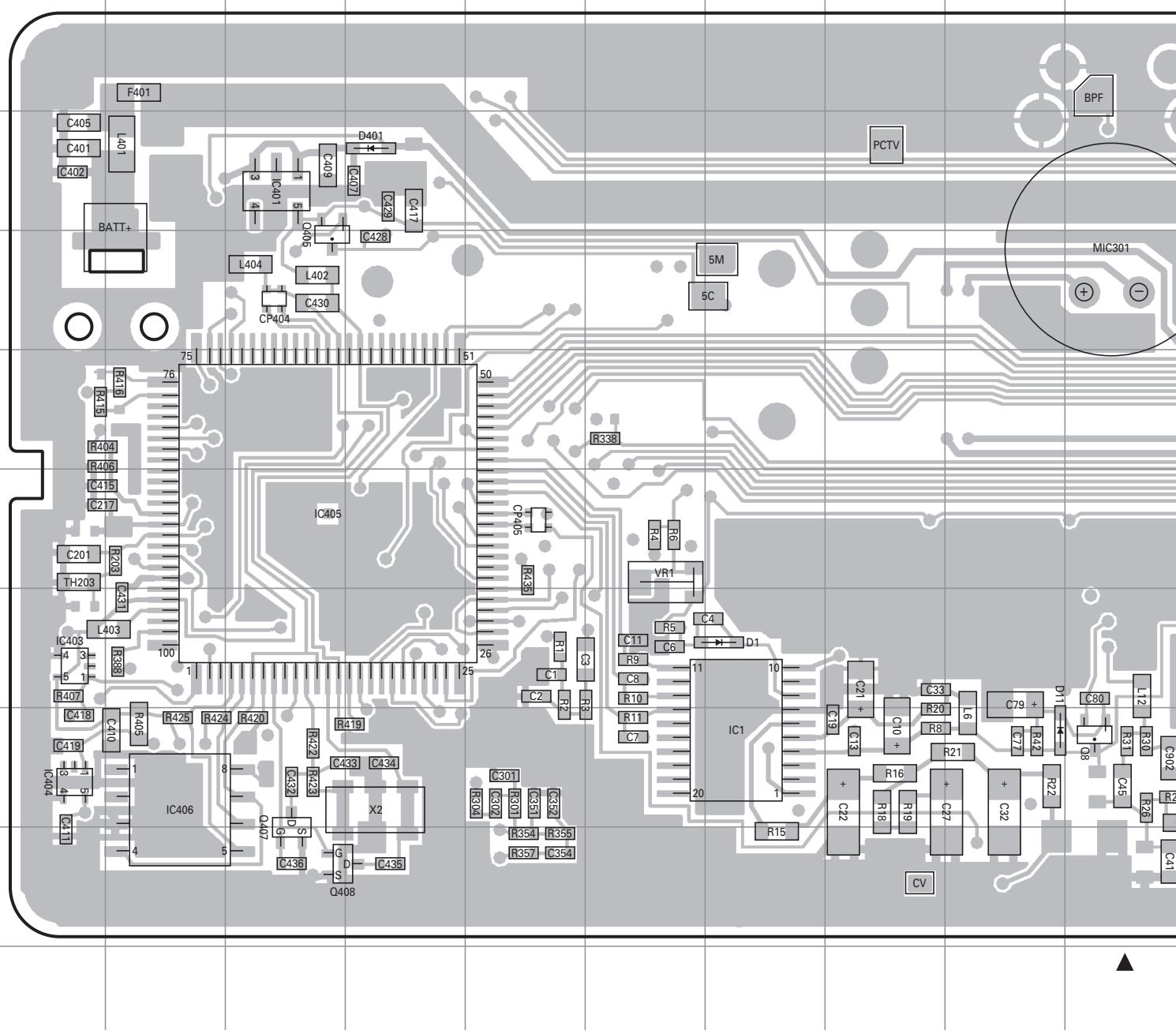
ADJUSTMENT

Receiver Section

Item	Condition	Measurement		Adjustment		Specifications/ Remark
		Test equipment	Terminal	Parts	Method	
1.BPF Wave Check	Spectrum analyzer setting Center-f : 446MHz Span : 150MHz RBW : 100kHz VBW : 10kHz ATT : 5dB	Spectrum analyzer	ANT BPF		Check the waveform as shown to the right.	 REF -40.0 dBm Selv A_Vwrite Norm B_Blk Norm CENTER 446.0 MHz SPAN 150.0 MHz +RBW 100 kHz +VBW 10 kHz +SWP 300ms ATT 5 dB
2.Sensitivity check	TEST CH: 1-1 SSG output:-115dBm(0.4μV) SSG MOD:1.5kHz	SSG DVM Oscilloscope AF VTVM	ANT		Check	20dB SINAD or more
3.SQL1 (Threshold) writing	TEST CH: 1-1 SSG output:12dB SINAD-4dB SSG MOD:1.5kHz			Programming Software: KPG-90D	Write	Squelch open
4.SQL9 (Tight) writing	TEST CH: 1-1 SSG output:12dB SINAD+2dB SSG MOD:1.5kHz				Write	BATT terminal voltage:5.9V
5.BATT Detection Writing	TEST CH: 1-1 BATT terminal voltage:5.9V	DVM	ANT BATT terminal			

TK-3201 PC BOARD

TX-RX UNIT (X57-6972-70) Component side view (J72-0950-09)



Ref. No.	Address						
IC1	9G	Q8	9J	Q305	8O	D1	8G
IC101	4M	Q104	5L	Q306	9P	D11	9I
IC302	8P	Q105	4K	Q316	9O	D102	4M
IC401	4C	Q107	4L	Q401	8R	D401	4D
IC403	8A	Q108	4L	Q402	8R	D403	8R
IC404	9A	Q109	5L	Q405	5C	D404	8R
IC405	7C	Q303	7P	Q407	9C		
IC406	9B	Q304	7P	Q408	10C		

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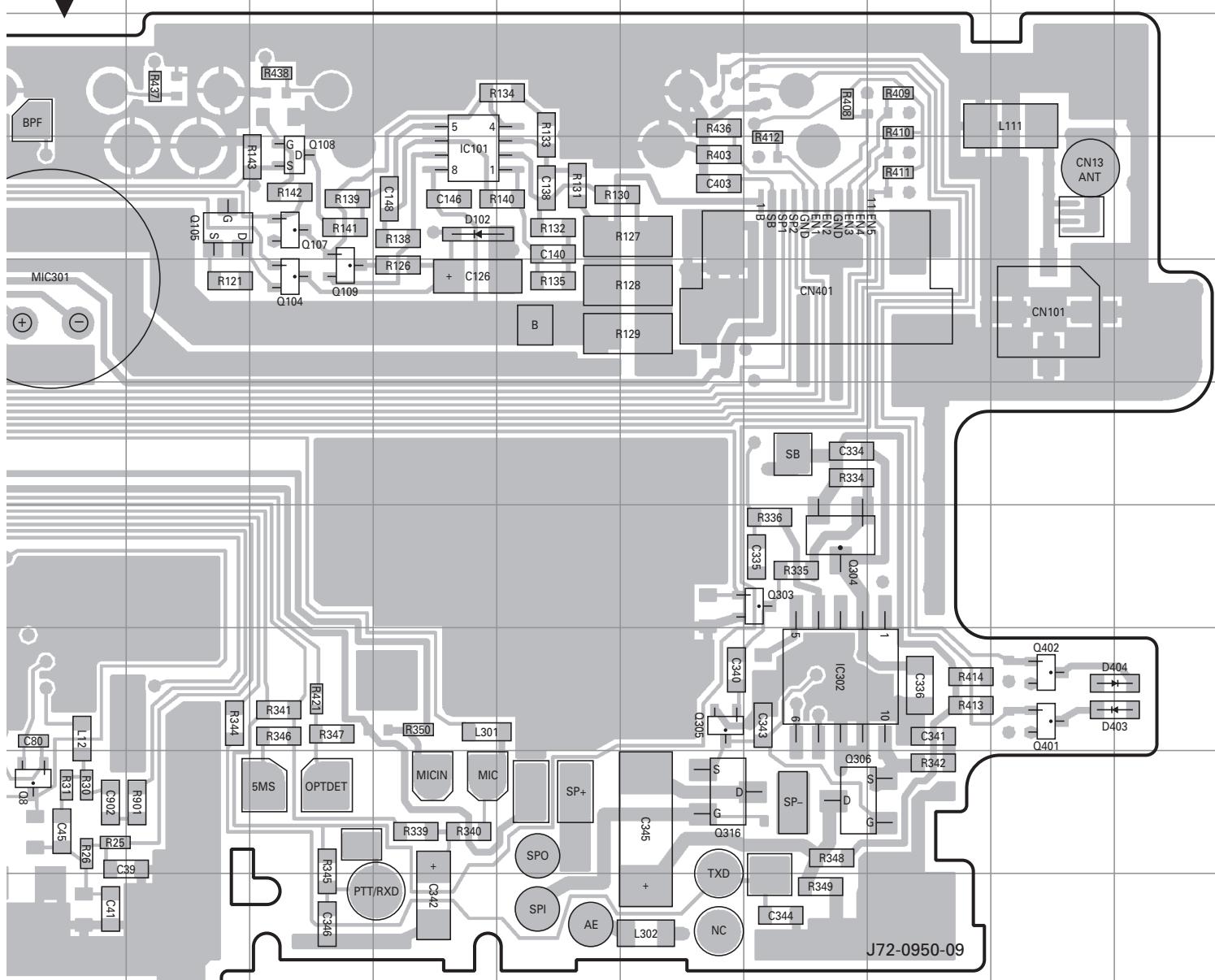
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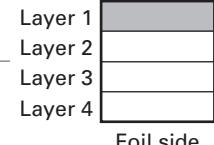
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PC BOARD TK-3201

TX-RX UNIT (X57-6972-70) Component side view (J72-0950-09)



Component side



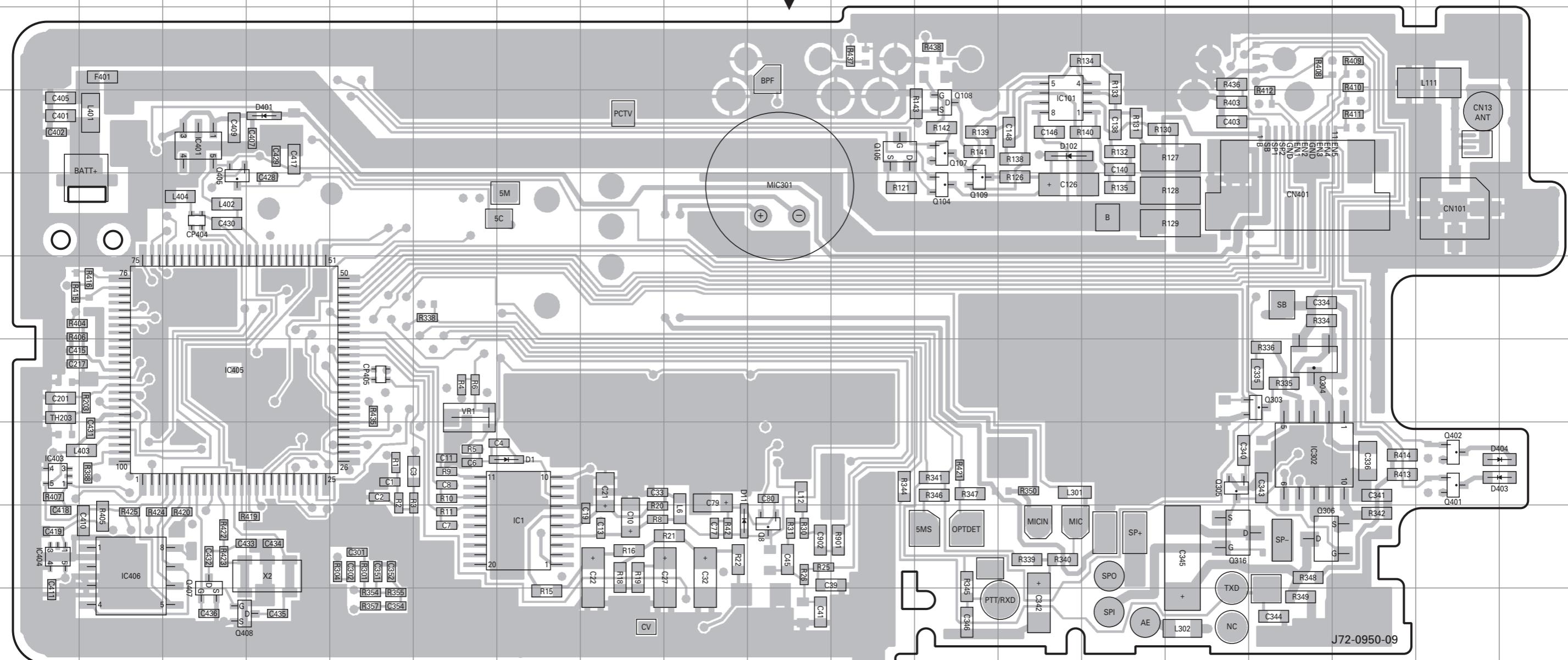
Foil side

TK-3201 PC BOARD

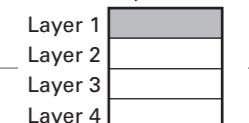
PC BOARD TK-3201

TX-RX UNIT (X57-6972-70) Component side view (J72-0950-09)

TX-RX UNIT (X57-6972-70) Component side view (J72-0950-09)



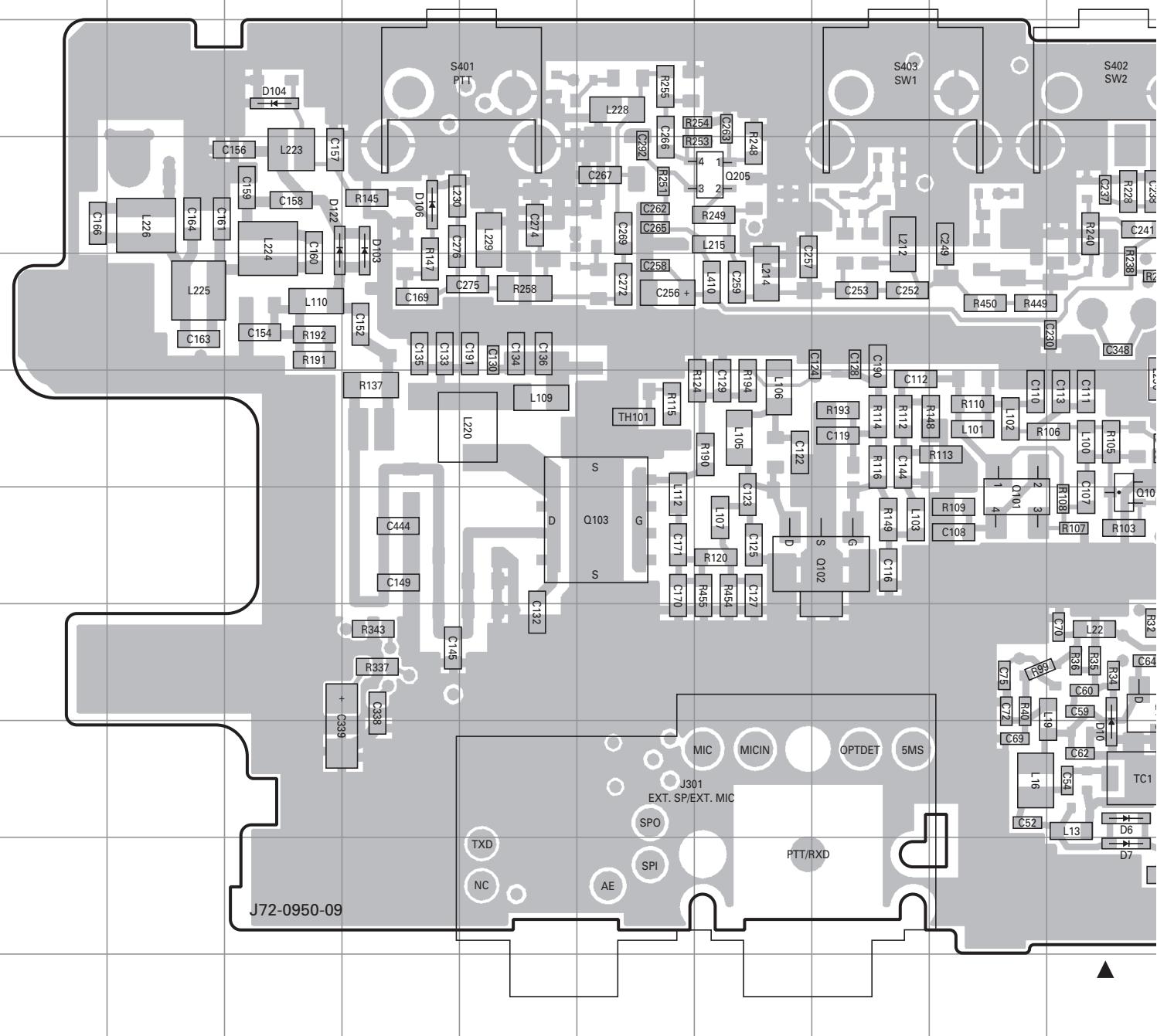
Component side



Ref. No.	Address						
IC1	9G	Q8	9J	Q305	8O	D1	8G
IC101	4M	Q104	5L	Q306	9P	D11	9I
IC302	8P	Q105	4K	Q316	9O	D102	4M
IC401	4C	Q107	4L	Q401	8R	D401	4D
IC403	8A	Q108	4L	Q402	8R	D403	8R
IC404	9A	Q109	5L	Q405	5C	D404	8R
IC405	7C	Q303	7P	Q407	9C		
IC406	9B	Q304	7P	Q408	10C		

TK-3201 PC BOARD

TX-RX UNIT (X57-6972-70) Foil side view (J72-0950-09)



Ref. No.	Address								
IC201	5N	Q9	6L	Q301	6P	D7	10J	D301	10R
IC301	8P	Q100	7J	Q302	9S	D10	9J	D302	7S
IC402	4Q	Q101	7I	Q317	6P	D101	6K	D303	8R
IC408	8Q	Q102	7H	Q403	4Q	D103	4D	D402	4R
Q1	70	Q103	7F	Q404	3Q	D104	3C	D405	10Q
Q2	8L	Q203	4N	D2	9K	D106	4D		
Q4	8J	Q204	4K	D4	9K	D122	4C		
Q6	8K	Q205	4G	D6	9J	D202	6K		

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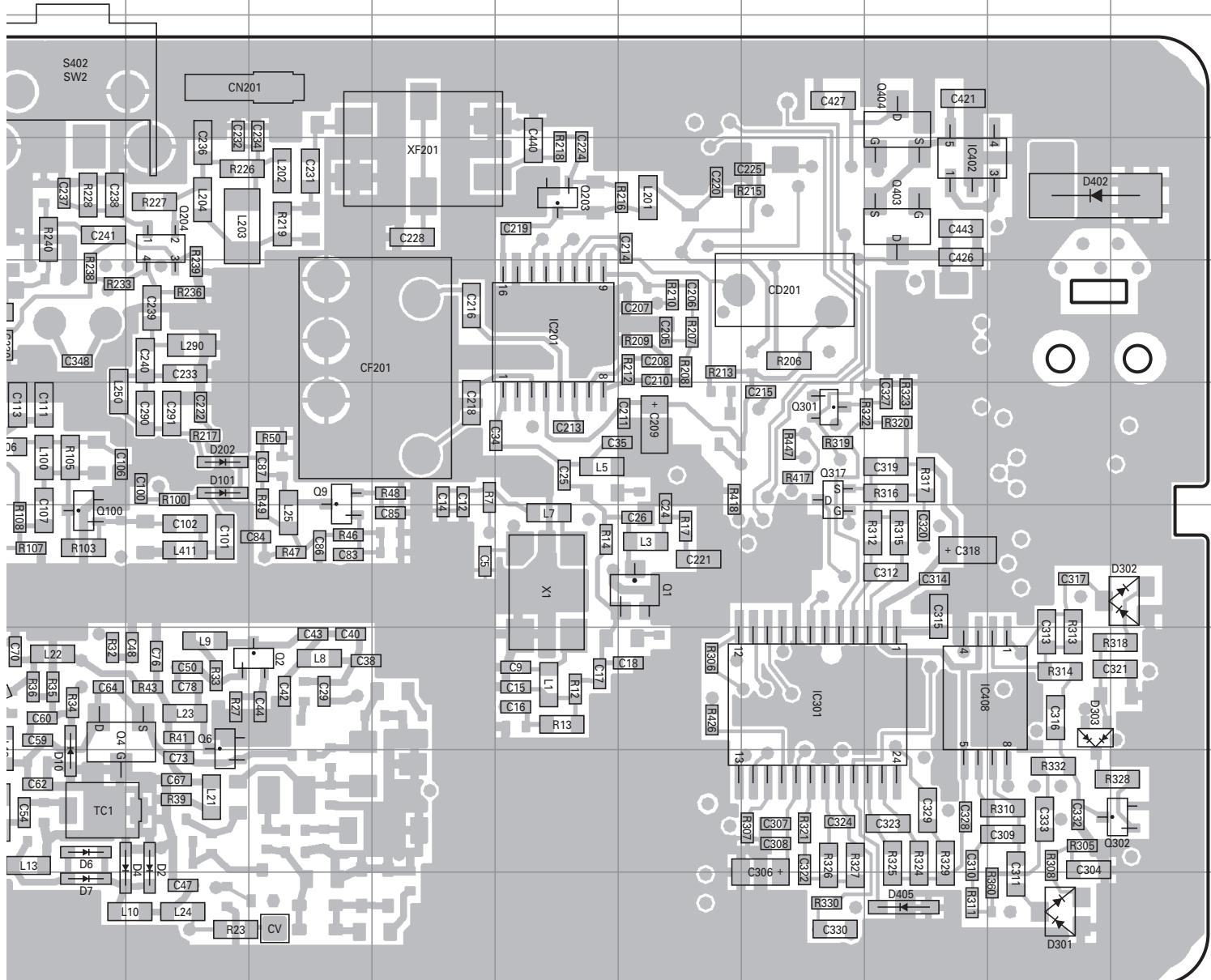
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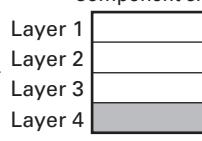
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PC BOARD TK-3201

TX-RX UNIT (X57-6972-70) Foil side view (J72-0950-09)



Component side



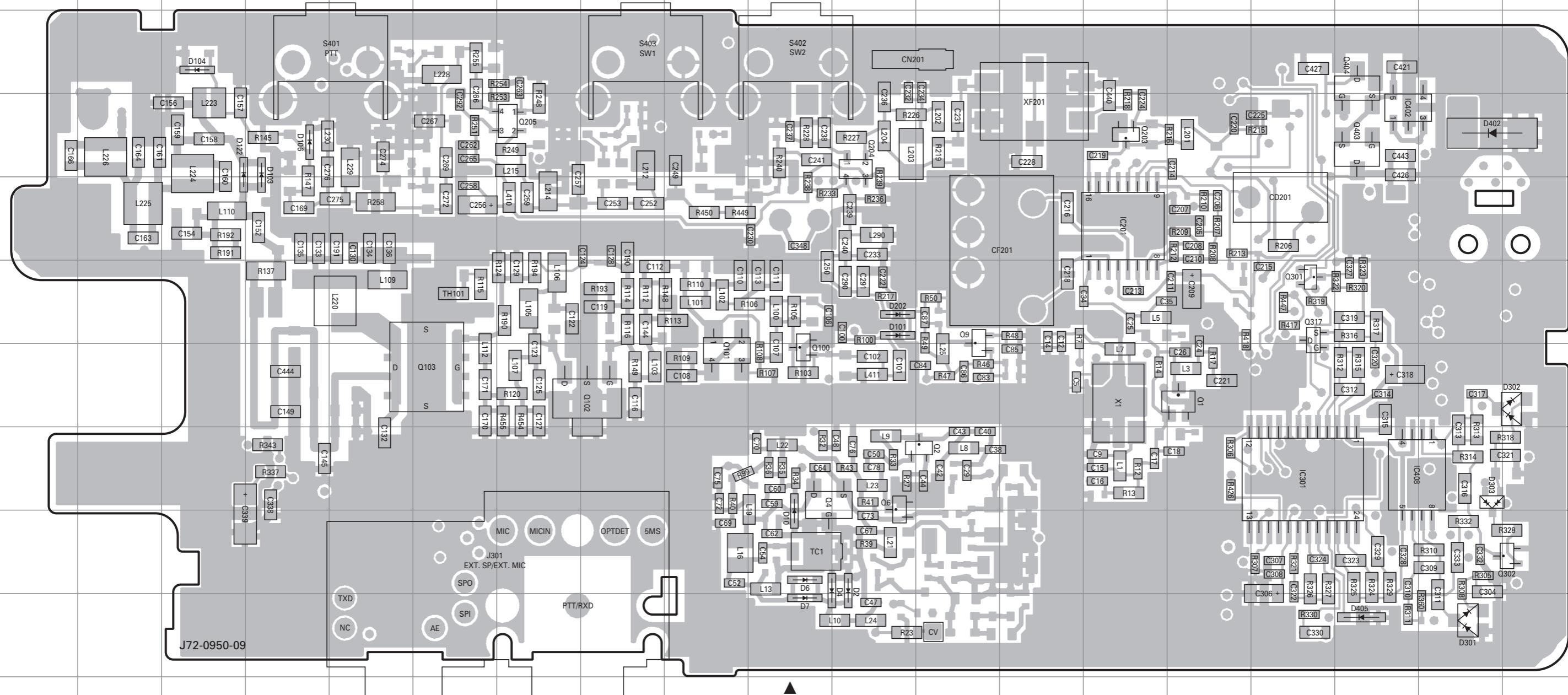
Foil side

TK-3201 PC BOARD

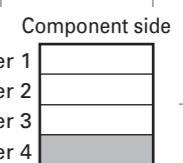
PC BOARD TK-3201

TX-RX UNIT (X57-6972-70) Foil side view (J72-0950-09)

TX-RX UNIT (X57-6972-70) Foil side view (J72-0950-09)



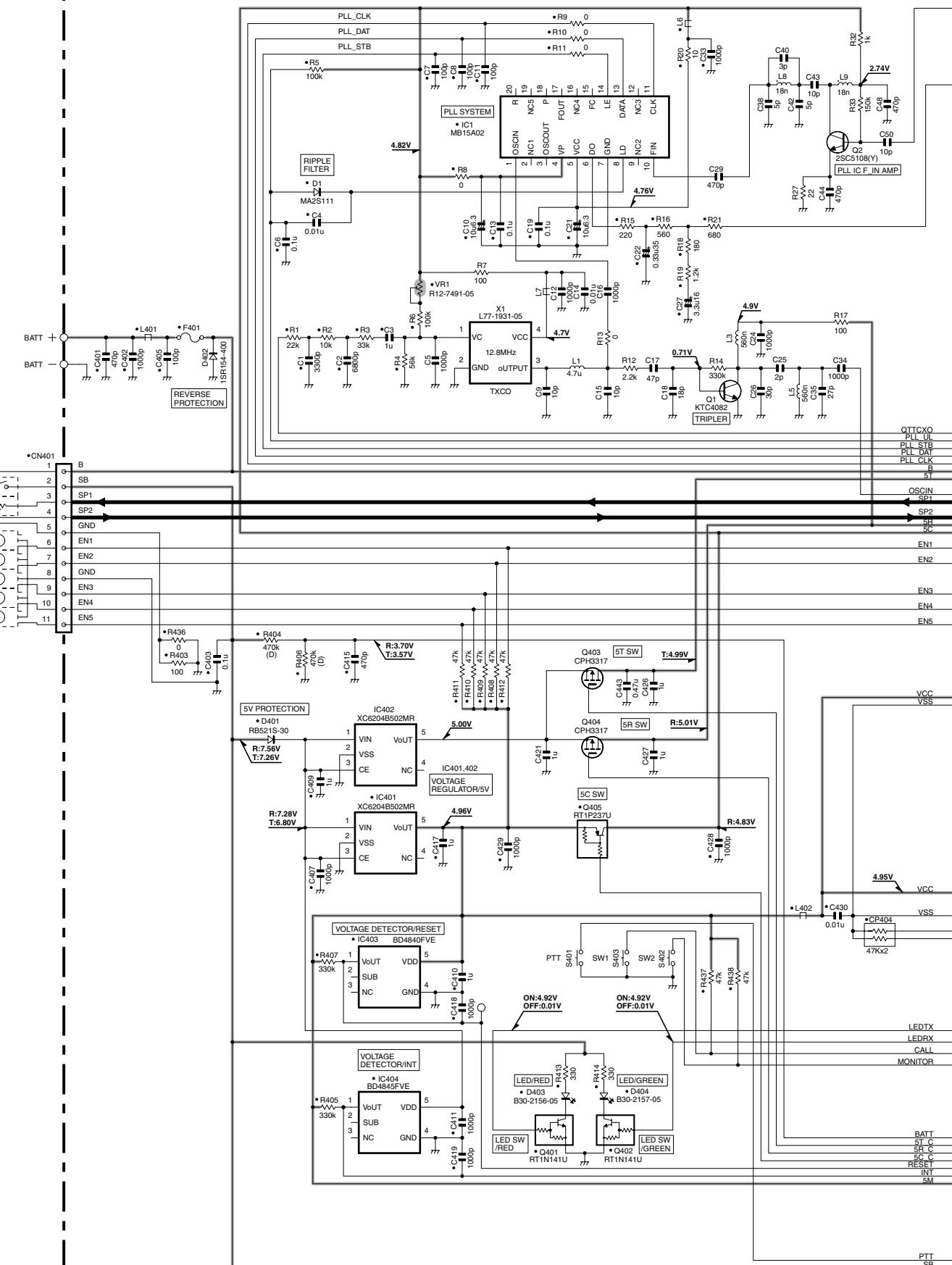
Ref. No.	Address								
IC201	5N	Q9	6L	Q301	6P	D7	10J	D301	10R
IC301	8P	Q100	7J	Q302	9S	D10	9J	D302	7S
IC402	4Q	Q101	7I	Q317	6P	D101	6K	D303	8R
IC408	8Q	Q102	7H	Q403	4Q	D103	4D	D402	4R
Q1	7O	Q103	7F	Q404	3Q	D104	3C	D405	10Q
Q2	8L	Q203	4N	D2	9K	D106	4D		
Q4	8J	Q204	4K	D4	9K	D122	4C		
Q6	8K	Q205	4G	D6	9J	D202	6K		



Foil side

TK-3201 SCHEMATIC DIAGRAM

TX-RX UNIT (X57-6972-70)



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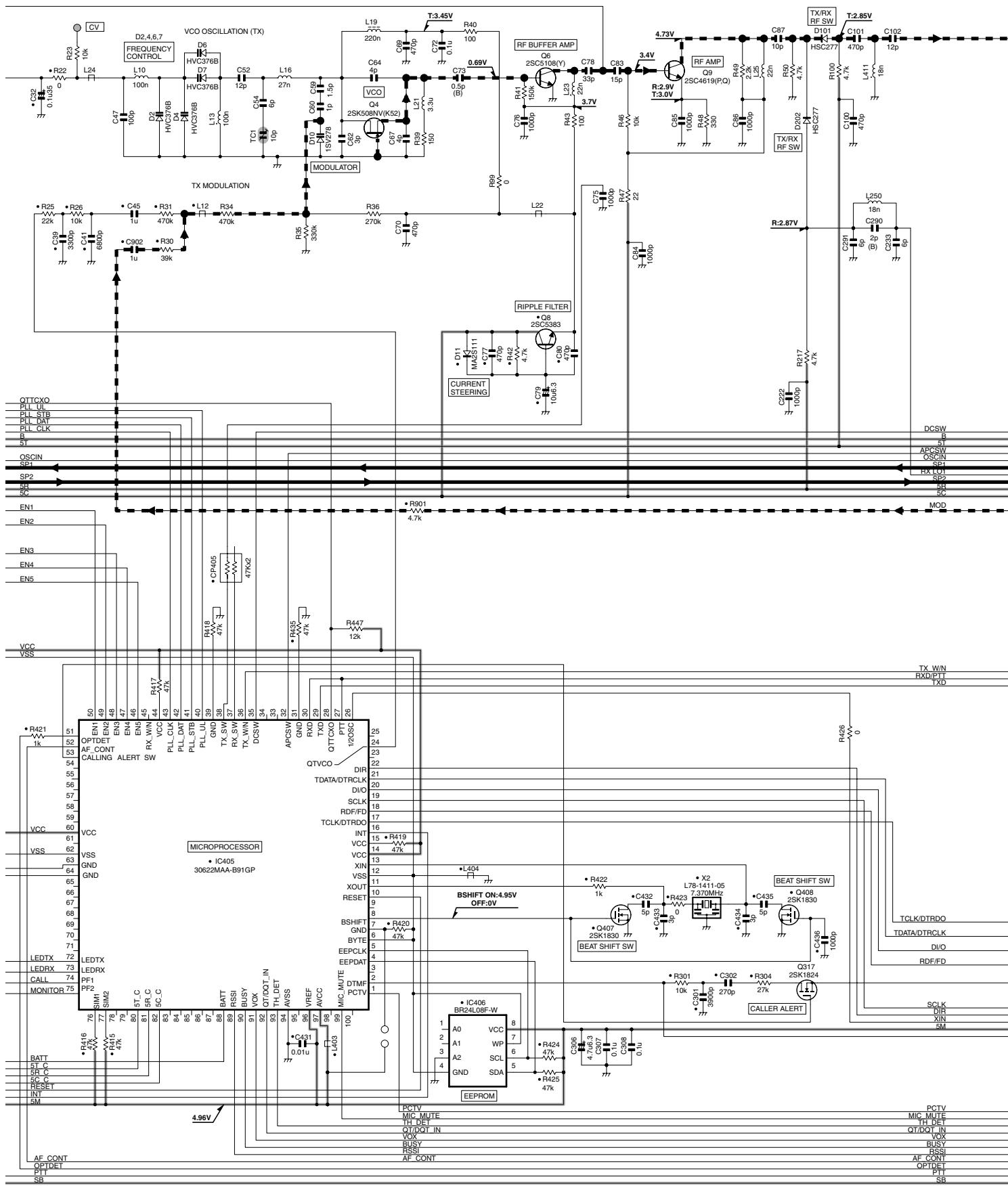
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SCHEMATIC DIAGRAM TK-3201

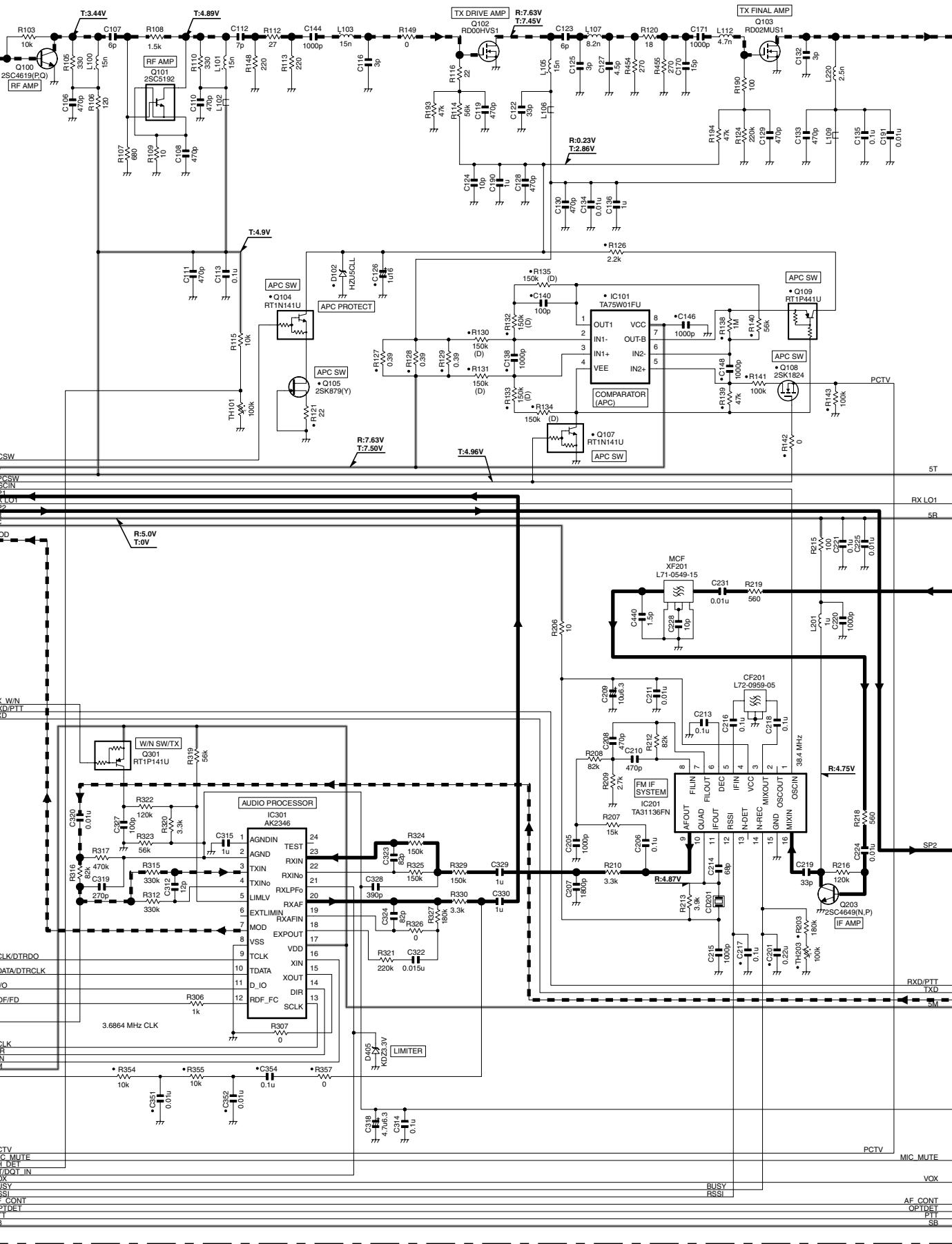
TX-RX UNIT (X57-6972-70)



K L M N O

TK-3201 SCHEMATIC DIAGRAM

TX-RX UNIT (X57-6972-70)

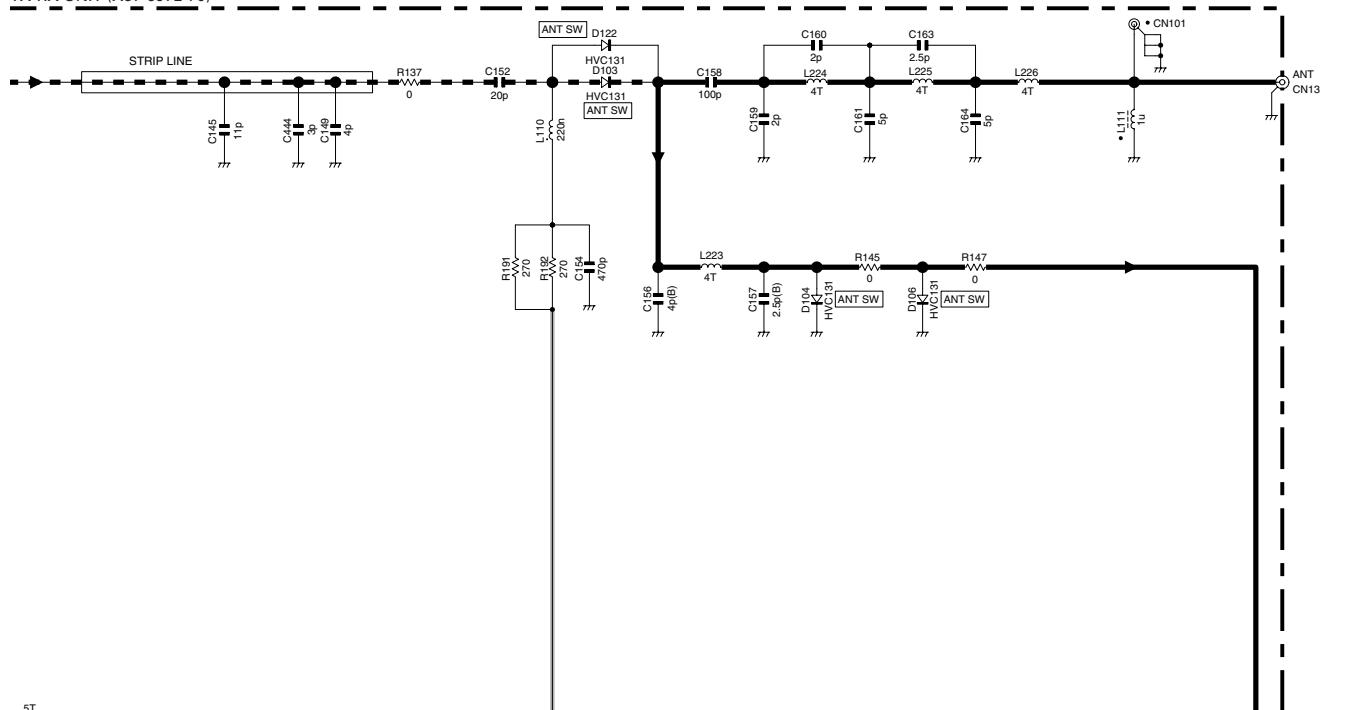


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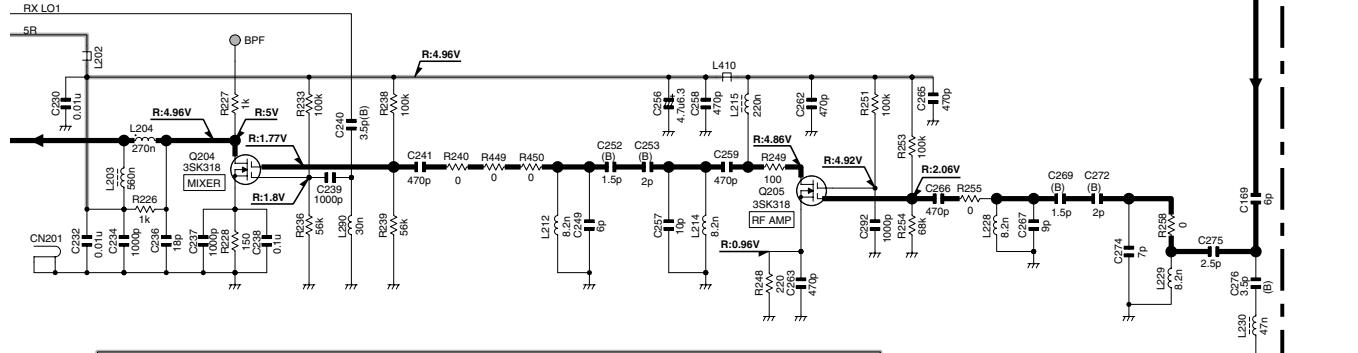
SCHEMATIC DIAGRAM TK-3201

TX-RX UNIT (X57-6972-70)

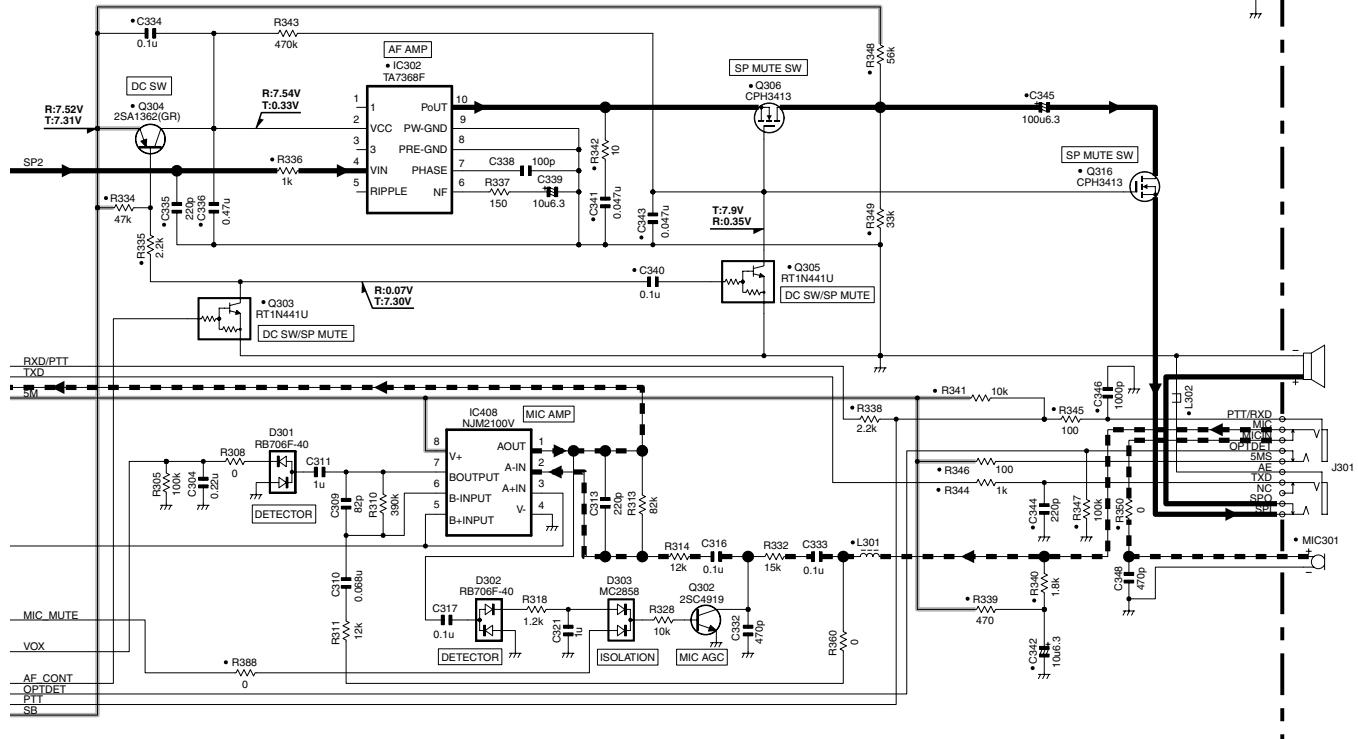
Note : The components marked with a dot (●) are parts of layer1.



5T



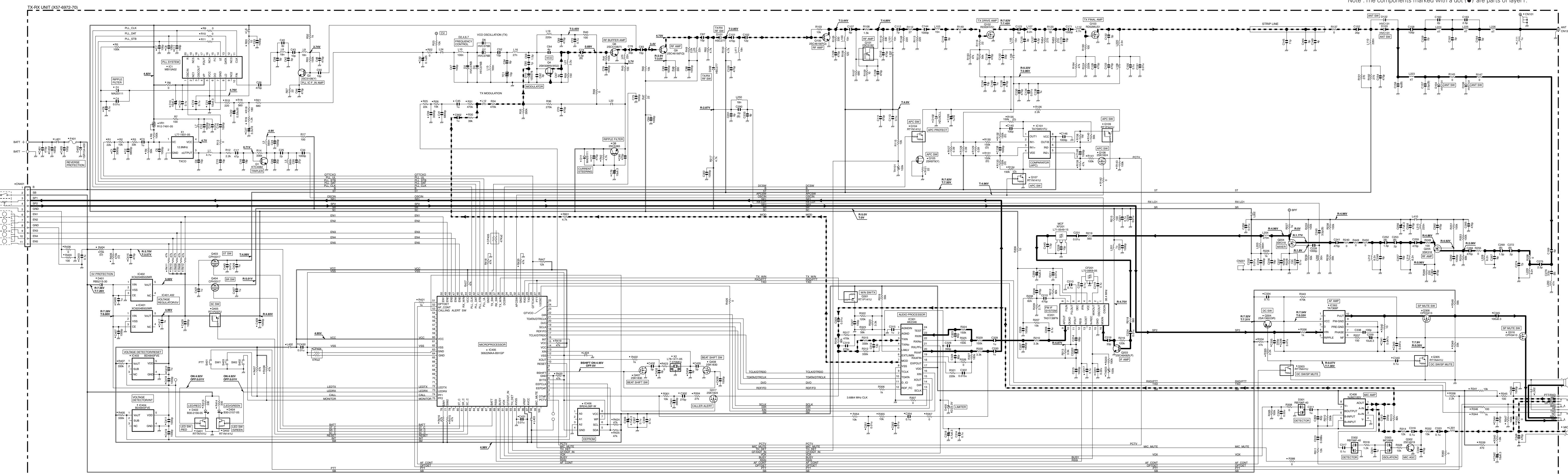
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TK-3201 SCHEMATIC DIAGRAM

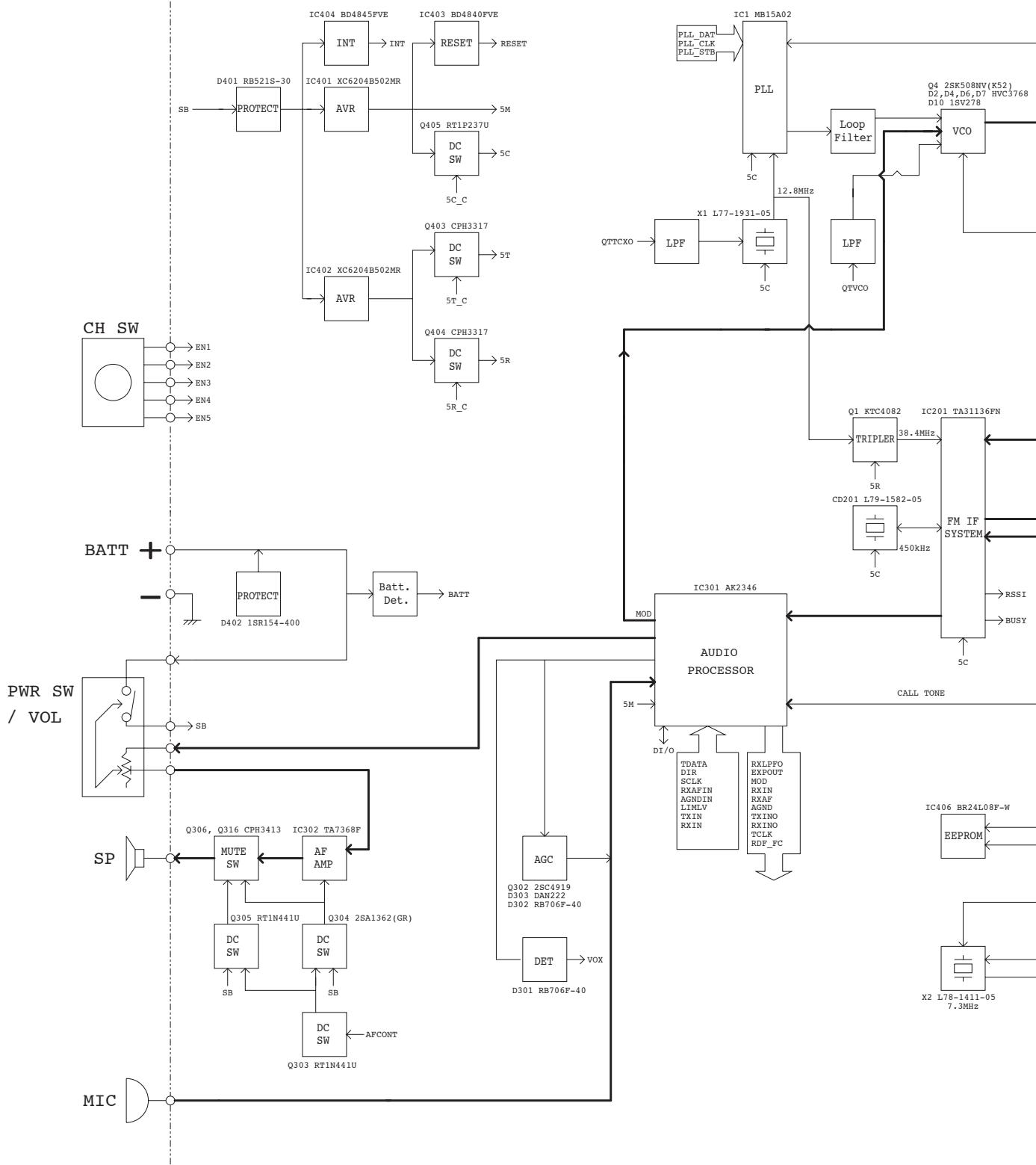
Note : The components marked with a dot (●) are parts of layer1.



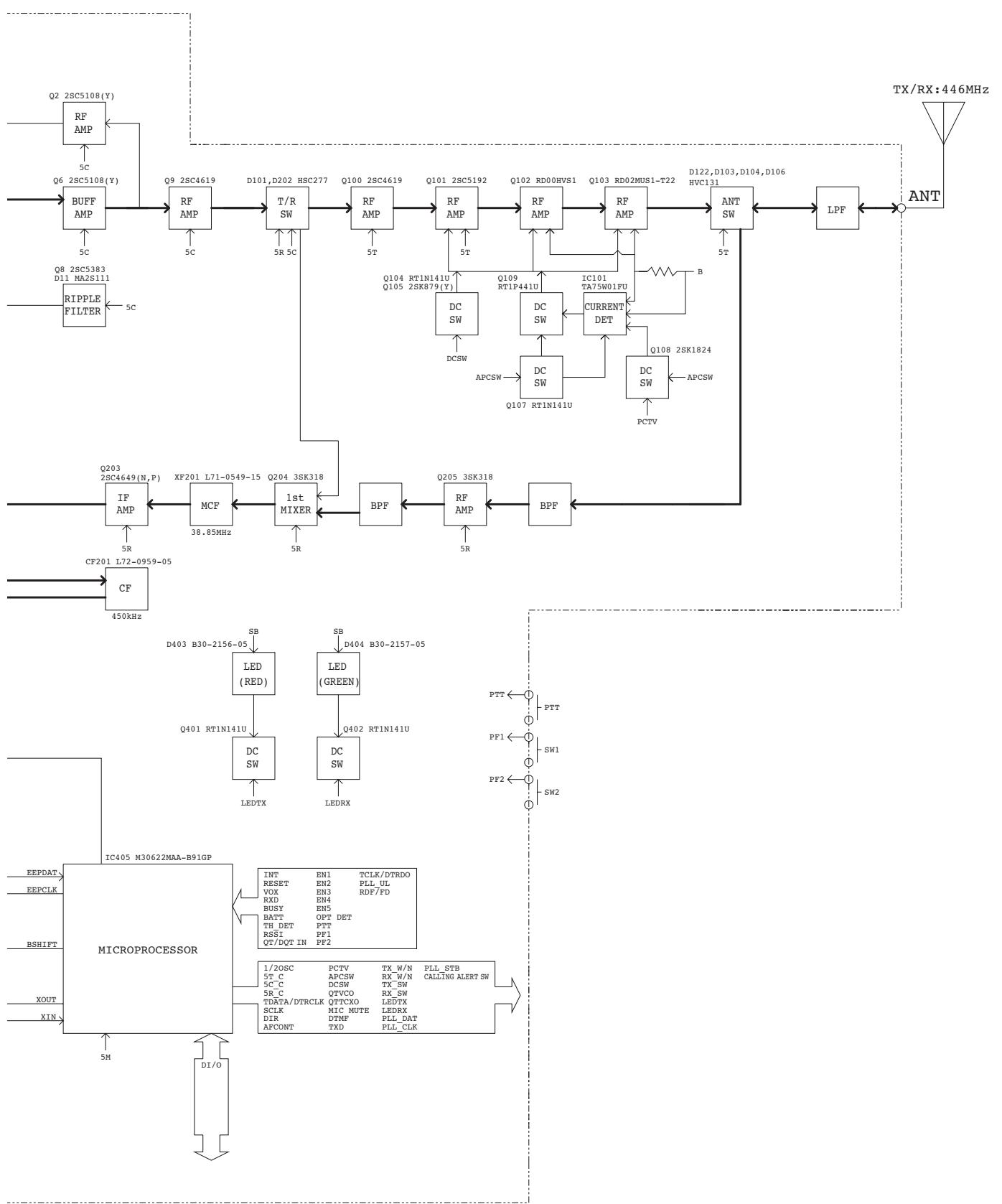
TK-3201

BLOCK DIAGRAM

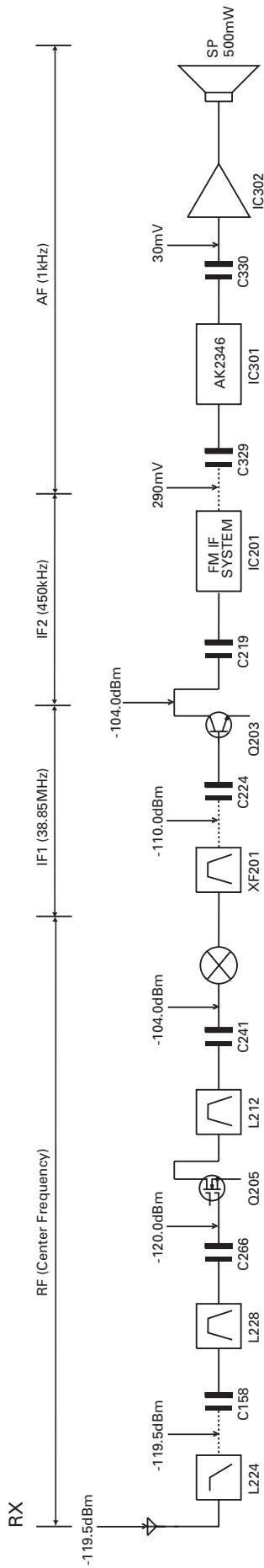
X57-697



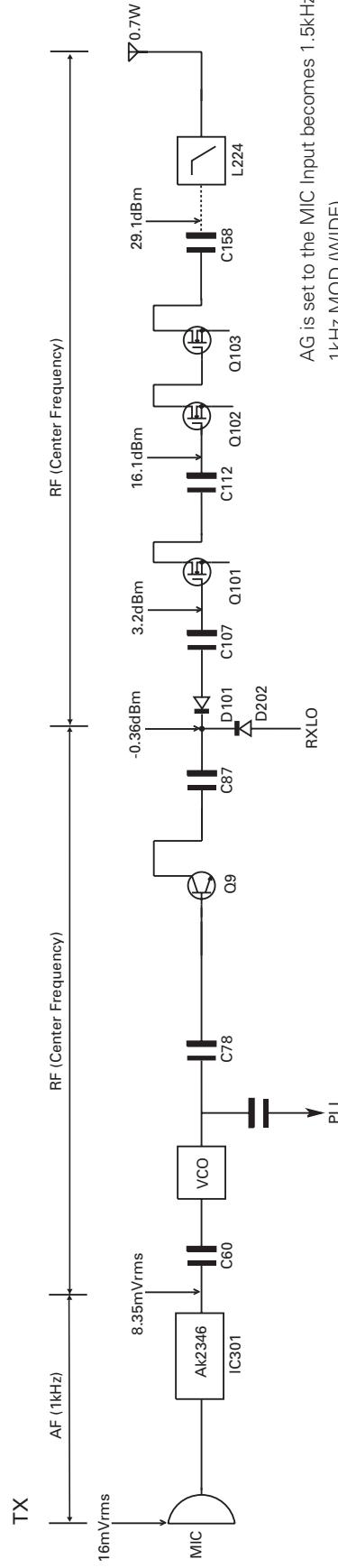
BLOCK DIAGRAM



LEVEL DIAGRAM



To make measurements in the AF section, connect the AC level meter. (ANT input: -53dBm, 1kHz FM, 1.5kHz DEV)
 In the RF section, use 1000pF coupling capacitor.
 (The display shows the SSG input value required to obtain 12dB SINAD without Local Level.)

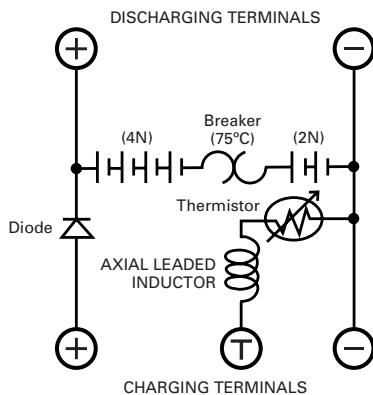


KSC-31 / KNB-29N / KNB-30A / KBH-10**KSC-31 (RAPID CHARGER)****■ External View****■ Specifications**

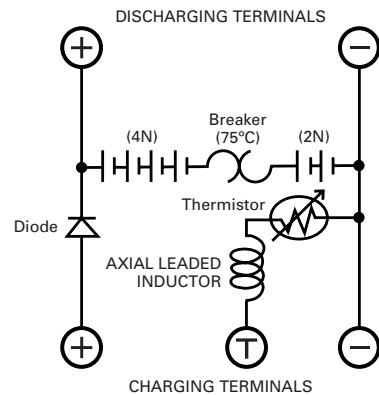
Charging current 850mA ±5%
 Charging time KNB-29N : Approx.180 minutes
 KNB-30A : Approx.120 minutes
 Dimensions (Charger only) 86.3W x 46.2H x 100.0D (mm)
 3-3/8W x 1-7/8H x 4D (inches)
 Weight (Charger only) Approx.100g / 0.22 lbs

KNB-30A (Ni-Cd BATTERY PACK)**■ External View****■ Specifications**

Voltage 7.2V (1.2V x 6)
 Battery capacity... 1100mAh

■ Schematic Diagram**KNB-29N (Ni-MH BATTERY PACK)****■ External View****■ Specifications**

Voltage 7.2V (1.2V x 6)
 Battery capacity ... 1500mAh

■ Schematic Diagram**KBH-10 (BELT CLIP)****■ External View**

TK-3201

SPECIFICATIONS

General

Frequency Range	446.0~446.1MHz
Number of Channels	16
Channel Spacing	12.5kHz
PLL Channel Stepping	12.5kHz
Operating Voltage	7.5 V DC ±20%
Battery Life	
5-5-90 duty cycle with KNB-29N battery	Battery Saver off : Approx. 16 hours Battery Saver on and QT on : Approx. 20 hours Battery Saver on and QT off : Approx. 24 hours
5-5-90 duty cycle with KNB-30A battery	Battery Saver off : Approx. 11 hours Battery Saver on and QT on : Approx. 15 hours Battery Saver on and QT off : Approx. 17 hours
Operating Temperature range	-30°C to +60°C (-22 °F to +140 °F)
Frequency Stability	±2.5ppm (-30°C to +60°C)
Channel Frequency Spread	0.1MHz
Dimensions and Weight	
Radio Only	54 (2-1/8) W x 122 (4-13/16) H x 21.1 (13/16) D mm (inches) 163g (0.36 lbs)
With KNB-29N (1500mAh battery)	54 (2-1/8) W x 122 (4-13/16) H x 33 (1-5/16) D mm (inches) 363g (0.80 lbs)
With KNB-30A (1100mAh battery)	54 (2-1/8) W x 122 (4-13/16) H x 33 (1-5/16) D mm (inches) (Dimensions not including protrusions) 343g (0.76 lbs)

Receiver (Measurements made per EN standard)

Sensitivity	
EIA 12dB SINAD	0.28µV
EN 20dB SINAD	-3dBµV (0.7µV)
Selectivity	60dB
Intermodulation	60dB
Spurious Response	60dB
Audio Power Output	500mW at 8Ω less than 10% distortion

Transmitter (Measurements made per EN standard)

RF Power Output	ERP 0.5W
Spurious Response	65dB
Modulation	8K50F3E
FM Noise	40dB
Audio Distortion	Less than 5%

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